

HA12228F/HA12229F

Audio Signal Processor for Car Deck
(Decode only Dolby B-type NR* with PB Amp.)

REJ03F0134-0200
(Previous: ADE-207-325A)
Rev.2.00
Jun 15, 2005

Description

HA12228F/HA12229F are silicon monolithic bipolar IC providing Dolby noise reduction system*, music sensor, PB equalizer system in one chip.

Notes: 1. Dolby is a trademark of Dolby Laboratories Licensing Corporation.

A license from Dolby Laboratories Licensing Corporation is required for the use of this IC.

2. HA12229F is not built-in Dolby B-NR.

Functions

- PB equalizer × 2 channel
- Music sensor × 1 channel
- Dolby B-NR (Only HA12228F) × 2 channel
- Line mute SW × 2 channel

Features

- Different type of PB equalizer characteristics selection (120 μ s/70 μ s) is available with fully electronic control switching built-in.
- Easy interface with the PB head. (The PB-EQ resistance self-containing)
- Changeable to Forward, Reverse-mode for PB head with fully electronic control switching built-in.
- Available to change music sensing level by external resistor.
- Available to change response of music sensor by external capacitor.
- Music sensing level, built-in switch to change a band (MSG_V).
- NR ON/OFF fully electronic control switching built-in. (Only HA12228F)
- Line mute control switching built-in.
- Available to connect direct with MPU.
- These ICs are strong for a cellular phone noise.

Ordering Information

Operating Voltage

Product	Min	Max	Unit
HA12228F	6.5	12	V
HA12229F			

Note: 1. These ICs are designed to operate on single supply.

Standard Level

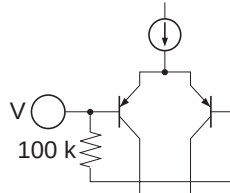
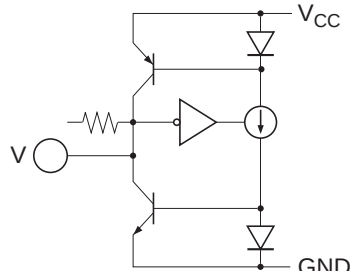
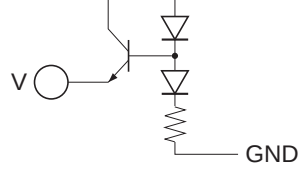
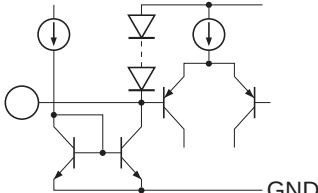
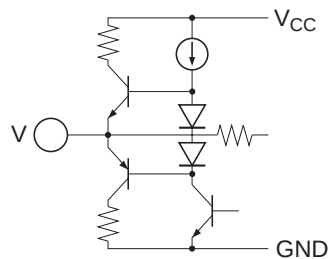
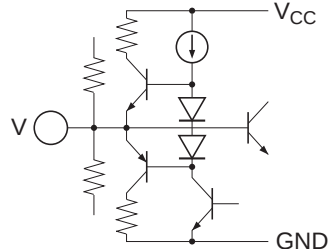
Product	Package Code (Previous Code)	PB-OUT Level
HA12228F	PLQP0040JB-A (FP-40B)	300 mVrms
HA12229F		

Function

Product	PB-EQ	Music Sensor	Mute	Dolby B-NR
HA12228F	○	○	○	○
HA12229F	○	○	○	×

Pin Description, Equivalent Circuit

(V_{CC} = 9 V single supply, T_a = 25°C, No Signal, The value in the table shows typical value.)

Pin No.	Terminal Name	Note	Equivalent Circuit	Description
13	MSI	$V = V_{CC}/2$		MS input * ¹
4	TAI(L)			Tape input
27	TAI(R)			
23 * ²	DET(R)	$V = 2.5\text{ V}$		Time constant pin for NR rectifier
8 * ²	DET(L)			Ripple filter
26	RIP			
5 * ³	Bias	$V = 0.28\text{ V}$		Dolby bias current input
14	MSDET	—		Time constant pin for MS rectifier * ¹
25	PBOUT(R)	$V = V_{CC}/2$		PB output
6	PBOUT(L)			MS amp. output * ¹
12	MAOUT			
29	EQOUT(R)	$V = V_{CC}/2$		Equalizer output
2	EQOUT(L)			

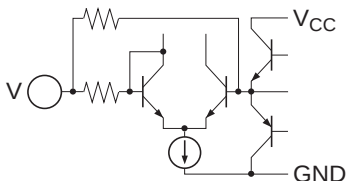
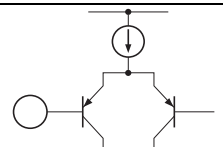
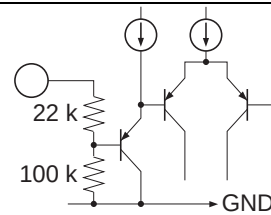
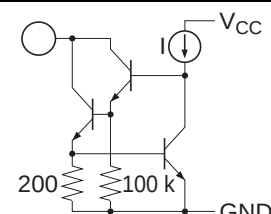
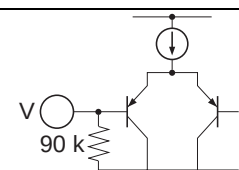
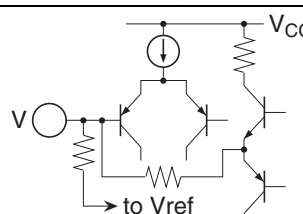
Notes: 1. MS: Music Sensor

2. Non connection regarding HA12229F.

3. Test pin regarding HA12229F. Usually open or pull down to GND with 18 kΩ.

Pin Description, Equivalent Circuit (cont.)

(V_{CC} = 9 V single supply, T_a = 25°C, No Signal, The value in the table shows typical value.)

Pin No.	Terminal Name	Note	Equivalent Circuit	Description
30	M-OUT(R)	V = V _{CC} /2		Equalizer output for time constant
1	M-OUT(L)			
37	FIN(R)	—		Equalizer input (FORWARD)
39	FIN(L)			Equalizer input (REVERSE)
35	RIN(R)			
33	RIN(L)			
20	MUTE ON/OFF	—		Mode control input
21 * ¹	NR ON/OFF			
19	120/70			
17	F/R			
18	S/R(MS G _v)			
16	MSOUT	—		MS output (to MPU) * ²
10	MS G _v (S)	V = V _{CC} /2		MS gain terminal * ²
11	MS G _v (R)			
31	NFI(R)	V = V _{CC} /2		Equalizer output for time constant
40	NFI(L)			

Notes: 1. Non connection regarding HA12229F.

2. MS: Music Sensor

Pin Description, Equivalent Circuit (cont.)

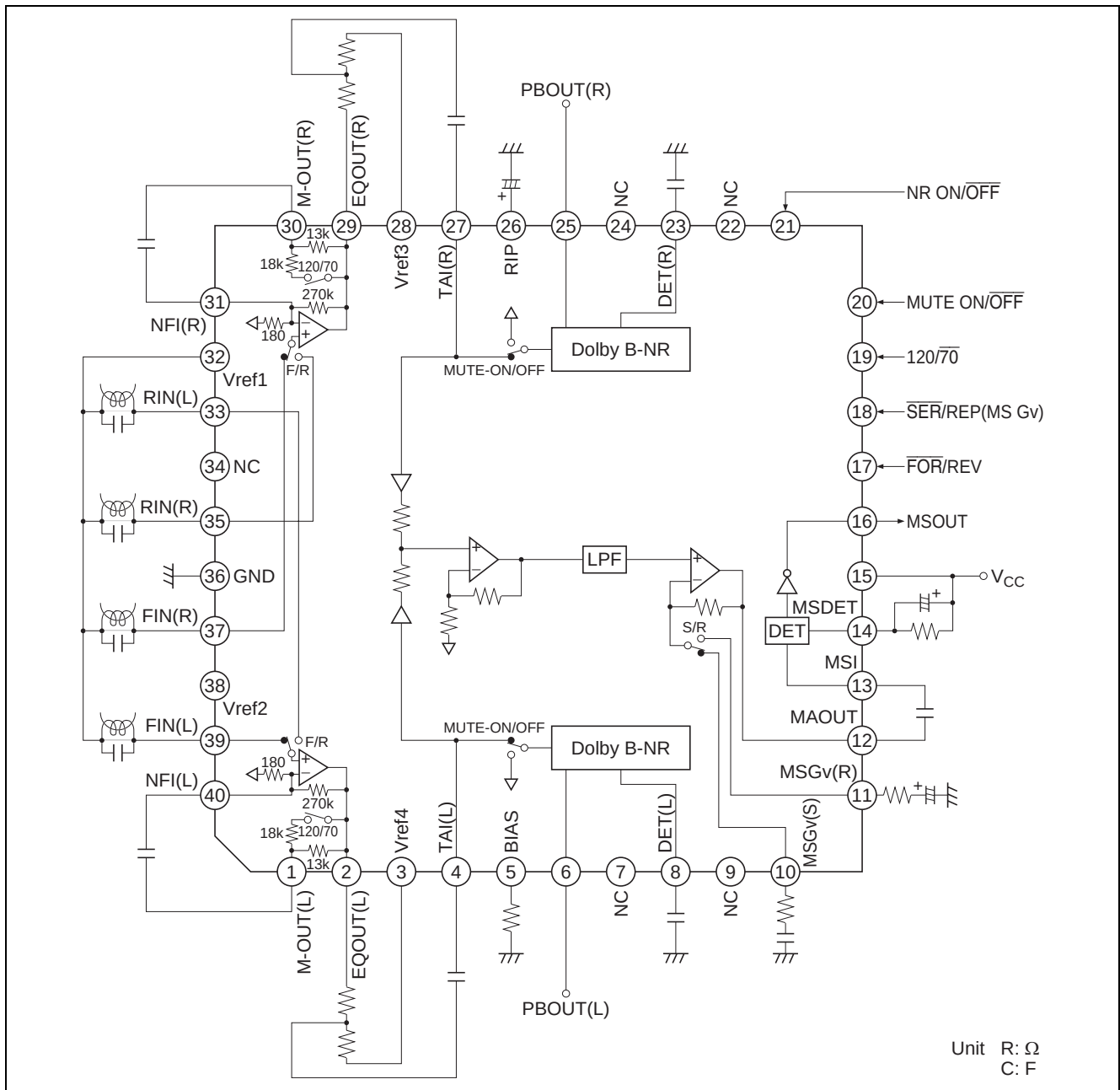
(V_{CC} = 9 V single supply, T_a = 25°C, No Signal, The value in the table shows typical value.)

Pin No.	Terminal Name	Note	Equivalent Circuit	Description
32	VREF1	V = V _{CC} /2		Reference output
38	VREF2			
28	VREF3			
3	VREF4			
15	V _{CC}	—		V _{CC} pin
36	GND	—		GND pin
7	NC	—		
9				
22				
24				
34				

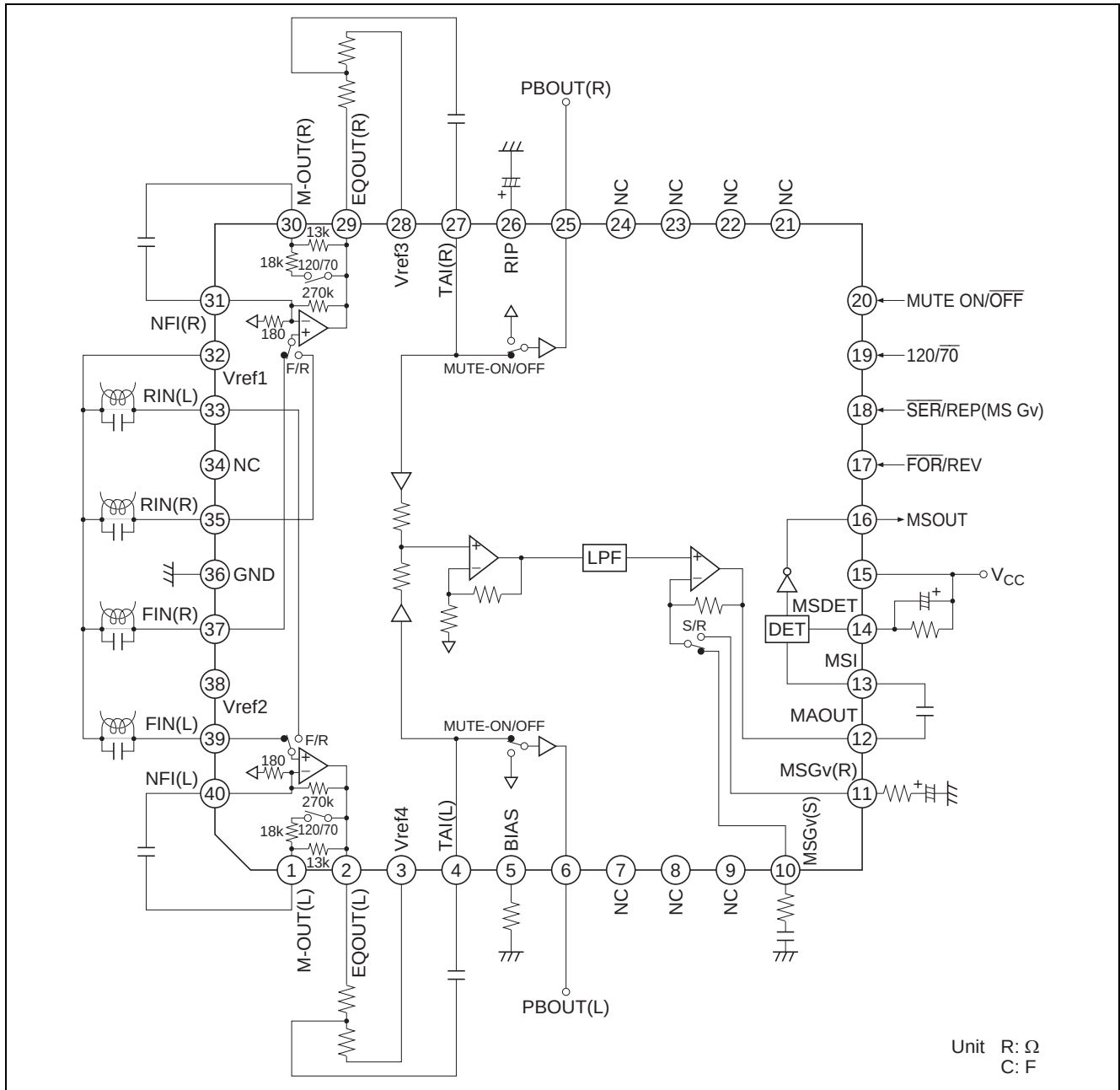
Note: 1. R_{AL}: Parasitic metal resistance

Block Diagram

HA12228F



HA12229F



Functional Description

Power Supply Range

HA12228F/HA12229F are provided with three line output level, which will permit on optimum overload margin for power supply conditions. And these are designed to operate on single supply only.

Table 1 Supply Voltage Range

Product	Single Supply
HA12228F	6.5 V to 12.0 V
HA12229F	

Note: The lower limit of supply voltage depends on the line output reference level.

The minimum value of the overload margin is specified as 12 dB by Dolby Laboratories.

Reference Voltage

These devices provide the reference voltage of half the supply voltage that is the signal grounds. As the peculiarity of these devices, the capacitor for the ripple filter is very small about 1/100 compared with their usual value. The block diagram is shown as figure 1.

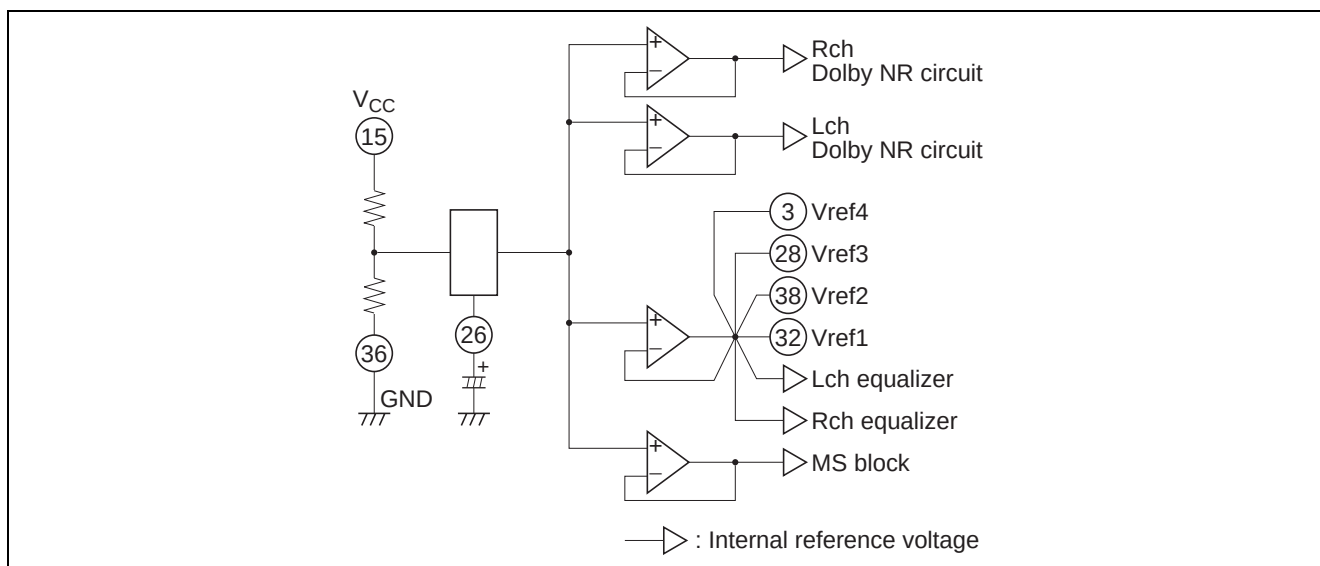


Figure 1a The HA12228F Block Diagram of Reference Supply Voltage

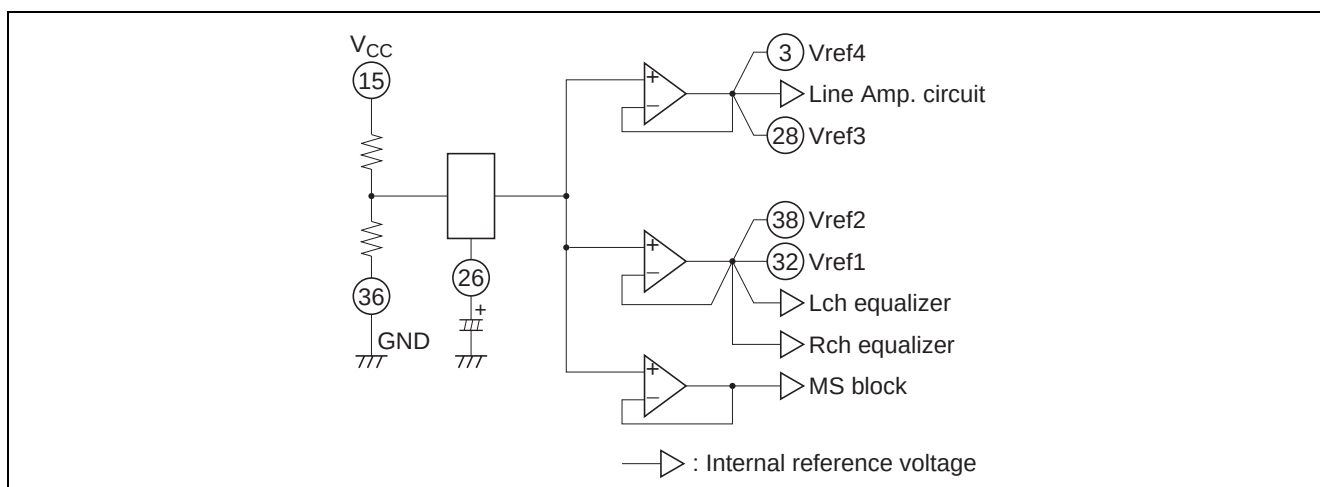


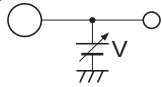
Figure 1b The HA12229F Block Diagram of Reference Supply Voltage

Operating Mode Control

HA12228F/HA12229F provides fully electronic switching circuits. And each operating mode control are controlled by parallel data (DC voltage).

When a power supply of this IC is cut off, for a voltage, in addition to a mode control terminal even though as do not destruct it, in series for resistance.

Table 2 Threshold Voltage (V_{TH})

Pin No.	Lo	Hi	Unit	Test Condition
17, 18, 19, 20, 21*	-0.2 to 1.0	3.5 to V_{CC}	V	Input Pin Measure 

Note: * Non connection regarding HA12229F.

Table 3 Switching Truth Table

Pin No.	Pin Name	Lo	Hi
17	Forward/Reverse	Forward	Reverse
18	Search/Repeat	Search (FF or REV)	Repeat (Normal speed)
19	120 μ /70 μ	70 μ (Metal or Chrome)	120 μ (Normal)
20	MUTE ON/OFF	MUTE-OFF	MUTE-ON
21*	NR ON/OFF	NR-OFF	NR-ON

Notes: * Non connection regarding HA12229F.

- Each pins are on pulled down with 100 k Ω internal resistor.
Therefore, it will be low-level when each pins are open.
- Over shoot level and under shoot level of input signal must be the standardized.
(High: V_{CC} , Low: -0.2 V)
- Reducing pop noise is so much better for 10 k Ω to 22 k Ω resisitor and 1 μ F to 22 μ F capacitor shown figure 2.

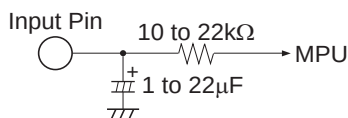


Figure 2 Interface for Reduction of Pop Noise

Input Block Diagram and Level Diagram

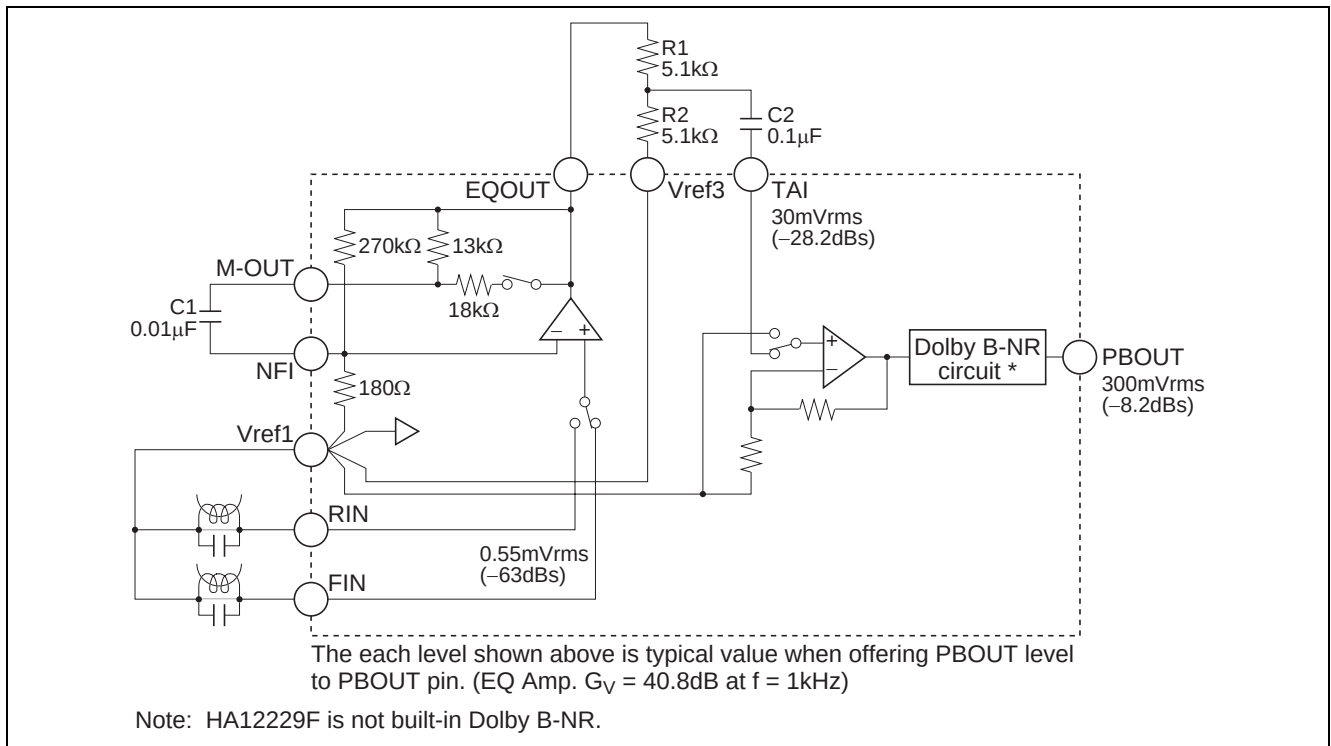


Figure 3 Input Block Diagram

Adjustment of Playback Dolby Level

After replace R5 and R6 with a half-fix volume of 10 kΩ, adjust playback Dolby level.

The Sensitivity Adjustment of Music Sensor

Adjusting MS Amp. gain by external resistor, the sensitivity of music sensor can set up. The music sensor block diagram is shown in figure 4, and frequency response is shown in figure 5.

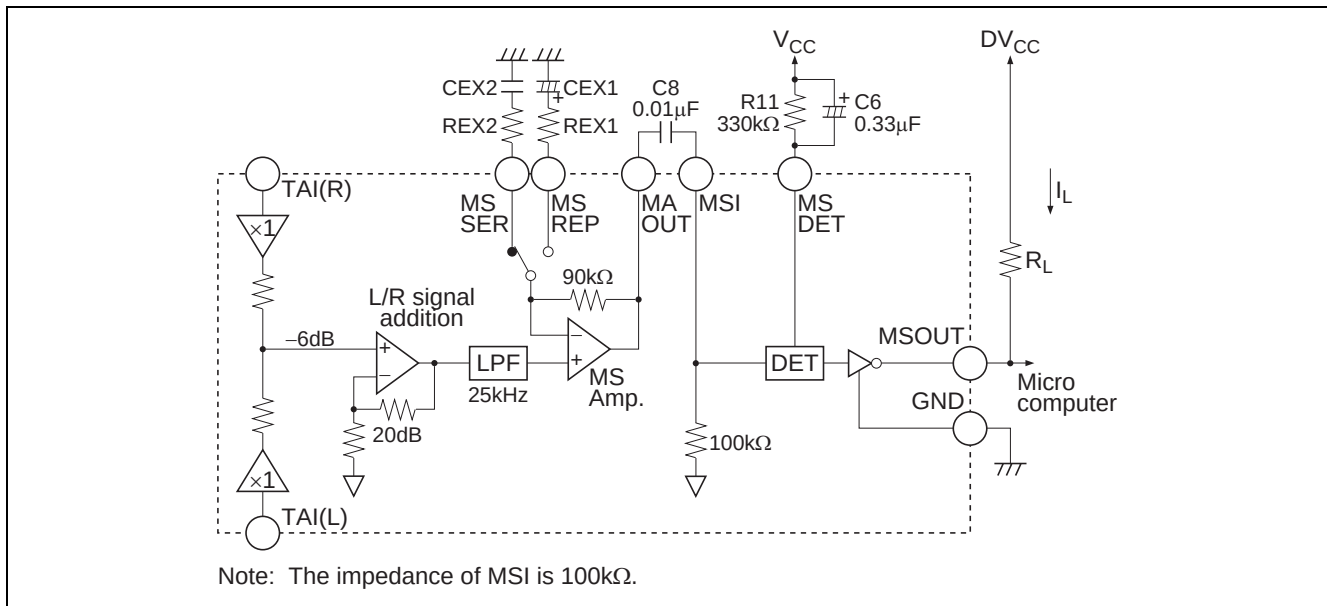


Figure 4 Music Sensor Block Diagram

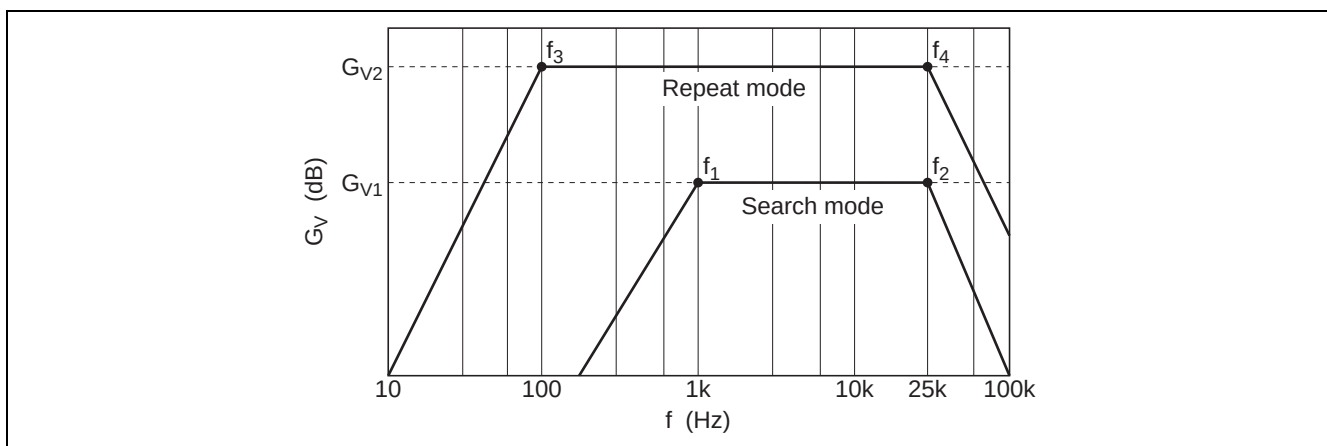


Figure 5 Frequency Response

1. Search mode

$$G_{V1} = 20\text{dB} + 20 \log \left(1 + \frac{90\text{k}}{\text{REX2}} \right) \text{ [dB]}$$

$$f_1 = \frac{1}{2\pi \cdot \text{CEX2} \cdot \text{REX2}} \text{ [Hz]}, f_2 = 25\text{k} \text{ [Hz]}$$

2. Repeat mode

$$G_{V2} = 20\text{dB} + 20 \log \left(1 + \frac{90\text{k}}{\text{REX1}} \right) \text{ [dB]}$$

$$f_3 = \frac{1}{2\pi \cdot \text{CEX1} \cdot \text{REX1}} \text{ [Hz]}, f_4 = 25\text{k} \text{ [Hz]}$$

G_{VIA} : L-R signal addition circuit gain.

The sensitivity of music sensor (S) is computed by the formula mentioned below.

$$S = - \left(G_V^{*1} - 20 \log \frac{130^{*3}}{30^{*2}} \right) = 12.7 - G_V \text{ [dB]}$$

Notes: 1. Search mode: G_{V1} , Repeat mode: G_{V2}

2. Standard level of TAI pin (Dolby level correspondence) = 30 mVrms

3. Standard sensing level of music sensor = 130 mVrms

Item	REX1, 2	CEX1, 2	$G_{V1, 2}$	$f_{1, 3}$	$f_{2, 4}$	S (one side channel)	S (both channel)
Search mode	24 k Ω	0.01 μ F	33.5 dB	663 Hz	25 kHz	-14.8 dB	-20.8 dB
Repeat mode	2.4 k Ω	1 μ F	51.7 dB	66.3 Hz	25 kHz	-33.0 dB	-39.0 dB

Note: S is 6 dB down in case of one-side channel. And this MS presented hysteresis lest MSOUT terminal should turn over again High level or Low level, in case of thresh S level constantly.

Music Sensor Time Constant

1. Sensing no signal to signal (Attack) is determined by C6, 0.01 μ F to 1 μ F capacitor C6 can be applicable.
2. Sensing signal to no signal (Recovery) is determined by C6 and R11, however preceding (1), 100 k Ω to 1 M Ω can be applicable.

Music Sensor Output (MSOUT)

As for the internal circuit of music sensor block, music sensor output pin is connected to the collector of NPN type directly, therefore, output level will be “high” when sensing no signal. And output level will be “low” when sensing signal.

$$I_L = \frac{DV_{CC} - \text{MSOUT}_{LO}^*}{R_L}$$

* MSOUT_{LO} : Sensing signal (about 1V)

Note: 1. Supply voltage of MSOUT pin must be less than V_{CC} voltage.

The Tolerances of External Components for Dolby NR (Only HA12228F)

For adequate Dolby NR tracking response, take external components shown below.

Also, leak is small capacity, and please employ a good quality object.

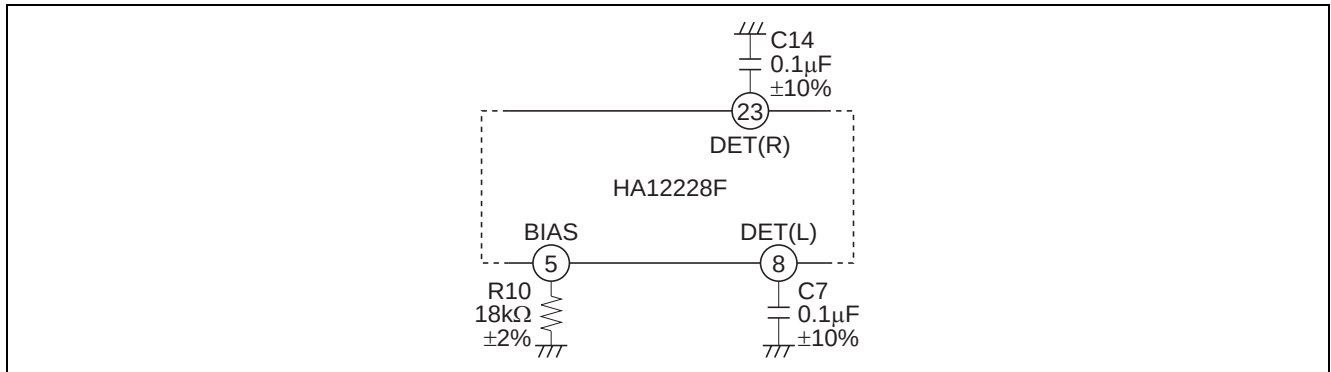


Figure 6 Tolerance of External Components

Countermeasure of a Cellular Phone Noise

This IC have reinforced a cellular phone noise countermeasure, to show it hereinafter.

However, it is presumed that this effect change it greatly, by a mount set.

Please sufficiently examine an arrangement of positions, shield method, wiring pattern, in order to obtain a maximum effect.

A high terminal of a noise sensitivity of this IC is FIN, RIN, NFI and RIP.

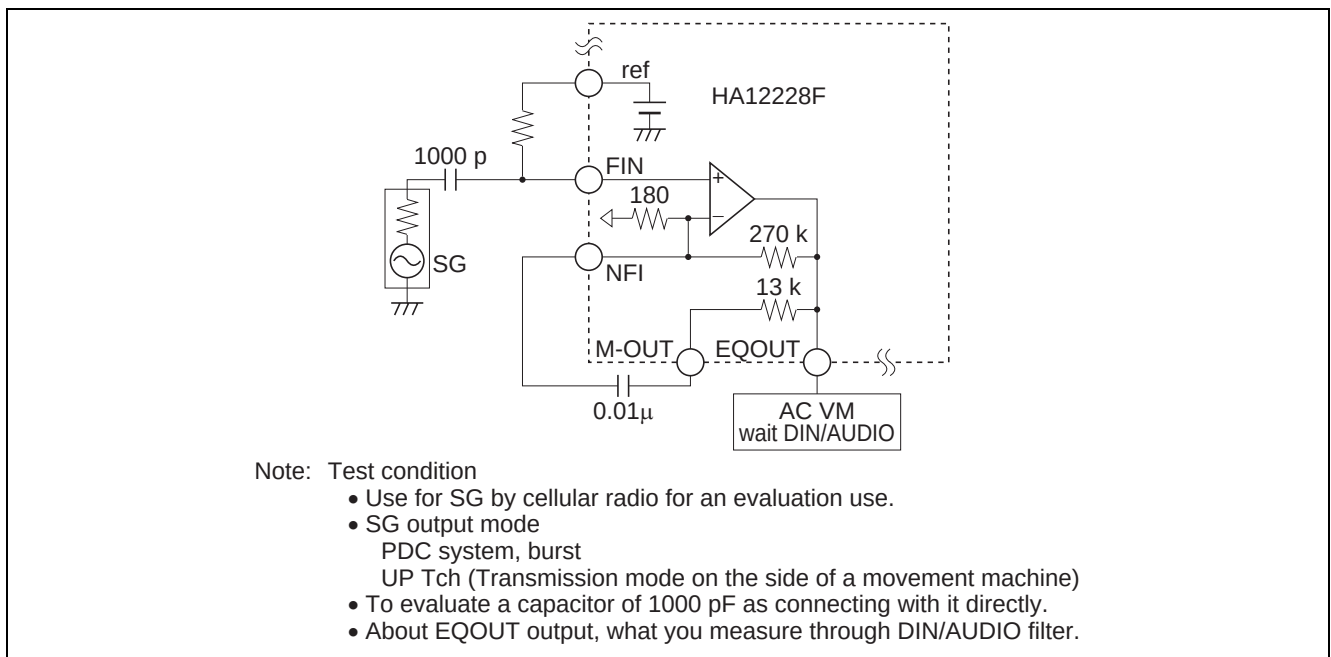


Figure 7 Test Circuit

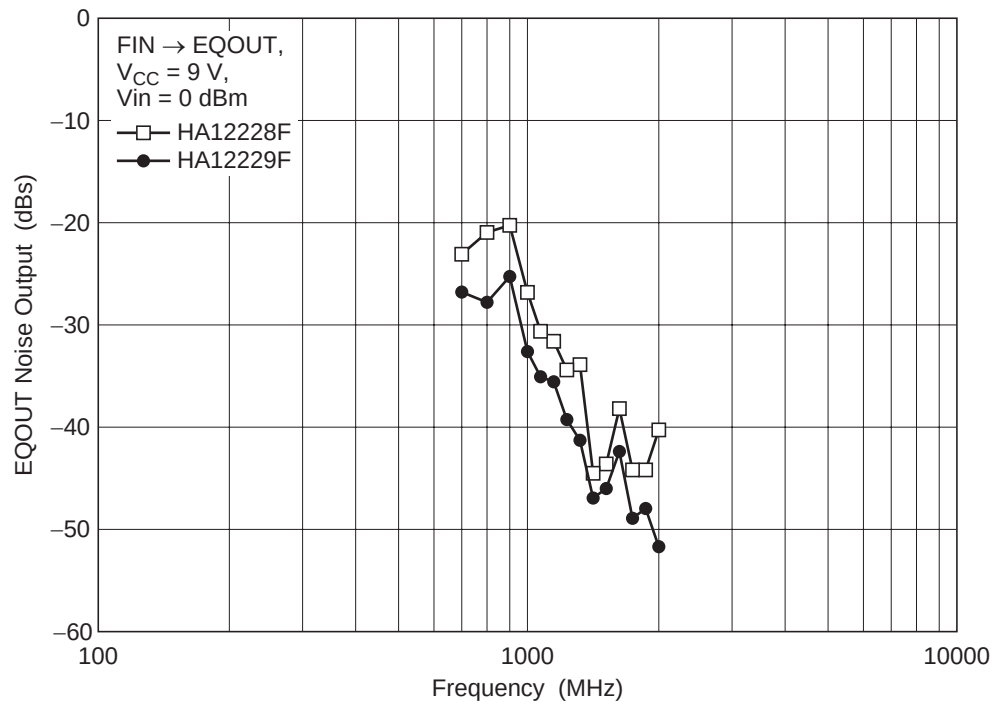


Figure 8 EQOUT Noise Output vs. Transmission Frequency Characteristic

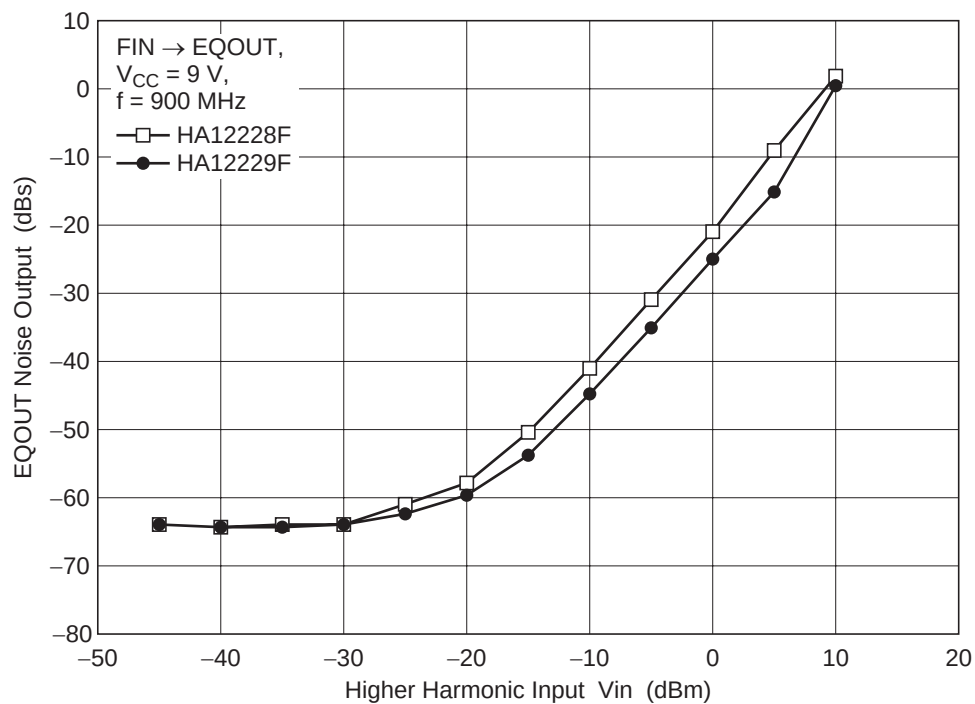


Figure 9 EQOUT Noise Output vs. Transmission Signal Input Level Characteristic

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Rating	Unit	Note
Maximum supply voltage	V _{CC} Max	16	V	
Power dissipation	Pd	400	mW	Ta ≤ 85°C
Operating temperature	Topr	−40 to +85	°C	
Storage temperature	Tstg	−55 to +125	°C	

Electrical Characteristics

HA12228F

(Ta = 25°C, V_{CC} = 9 V, Dolby level 0 dB = PBOUT level 0 dB = 300 mVrms, EQOUT level 0 dB = 60 mVrms)

Item	Symbol	Test Condition										Specification		Application Terminal				COM Remark
		IC Condition					Test Condition							Input		Output		
		NR ON/OFF	MUTE ON/OFF	120μ/70μ	SER/REP	FOR/REV	f _{in} (Hz)	PBOUT level (dB)	EQOUT level (dB)	Other		Min	Typ	Max	Unit	R	L	
Quiescent current	I _Q	OFF	OFF	70μ	SER	FOR	—	—	No signal		4.0	9.5	15.0	mA	—	—	—	15
Input Amp. gain B-type decode cut	G _V IA	OFF	OFF	—	—	—	1k	0	—		19.0	20.0	21.0	dB	27	4	25	6
	DEC 2k (1)	ON	OFF	—	—	—	2k	-20	—		-5.8	-4.3	-2.8	dB	27	4	25	6
	DEC 2k (2)	ON	OFF	—	—	—	2k	-30	—		-10.0	-8.5	-7.0	dB	27	4	25	6
	DEC 5k (1)	ON	OFF	—	—	—	5k	-20	—		-4.7	-3.2	-1.7	dB	27	4	25	6
DEC 5k (2)	ON	OFF	—	—	—	5k	-30	—		-9.7	-8.2	-6.7	dB	27	4	25	6	
PBOUT offset	V _{ofs}	OFF	OFF→ON	—	—	—	—	—	No signal		-150	0	150	mV	—	—	25	6
Signal handling	V _o max	ON	OFF	—	—	—	1k	—	THD=1%		12.0	13.0	—	dB	27	4	25	6
Signal to noise ratio	S/N	ON	OFF	—	—	—	1k	(0)	R _g =10kΩ, CCIR/ARM		70.0	80.0	—	dB	27	4	25	6
Total Harmonic Distortion	THD	ON	OFF	—	—	—	1k	0	—		—	0.05	0.3	%	27	4	25	6
Channel separation	CTRL (1)	—	—	—	—	FOR	1k	—	(÷20)		50.0	60.0	—	dB	37	39	29→22	29
CTRL (2)	CTRL (2)	OFF	OFF	—	—	—	1k	(+12)	—		70.0	80.0	—	dB	27	4	25→6	25
MUTE attenuation	CT MUTE	OFF	OFF→ON	—	—	—	1k	(+12)	—		70.0	80.0	—	dB	27	4	25	6
PB-EQ gain	G _V EQ 1k	—	—	120μ	—	FOR/REV	1k	—	0		37.8	40.8	43.8	dB	37/35	39/33	29	2
	G _V EQ 10k(1)	—	—	120μ	—	FOR	10k	—	0		33.9	36.9	39.9	dB	37	39	29	2
	G _V EQ 10k(2)	—	—	70μ	—	FOR	10k	—	0		29.6	32.6	35.6	dB	37	39	29	2
PB-EQ Maximum output level	V _{OM}	—	—	120μ	—	FOR	1k	—	THD=1%		300	600	—	mVrms	37	39	29	2
PB-EQ T.H.D.	THD-EQ	—	—	120μ	—	FOR/REV	1k	—	+14dB		—	0.1	0.3	%	37/35	39/33	29	2
PB-EQ input conversion noise	V _N	—	—	120μ	—	FOR/REV	(1k)	—	R _g =680Ω, DIN-AUDIO		—	0.7	1.5	μVrms	37/35	39/33	29	2
MS sensing level	V _{ON} (1)	OFF	OFF	—	SER	—	5k	—	—		-36.0	-32.0	-28.0	dB	27	4	25	6
V _{ON} (2)	V _{ON} (2)	OFF	OFF	—	REP	—	5k	—	—		-18.0	-14.0	-10.0	dB	27	4	25	6
MS output low level	V _{OL}	OFF	OFF	—	SER	—	5k	0	—		—	1.0	1.5	V	27	4	—	16
MS output leakage current	I _{OH}	—	—	—	—	—	—	—	No signal		—	0.0	2.0	μA	—	—	—	16
Control voltage	V _{IL}	—	—	—	—	—	—	—	—		-0.2	—	1.0	V	—	—	—	17 to 21
	V _{IH}	—	—	—	—	—	—	—	—		3.5	—	V _{CC}	V	—	—	—	21

Notes: 1. V_{CC} = 12V2. V_{CC} = 6.5V

3. For inputting signal to one side channel

HA12229F

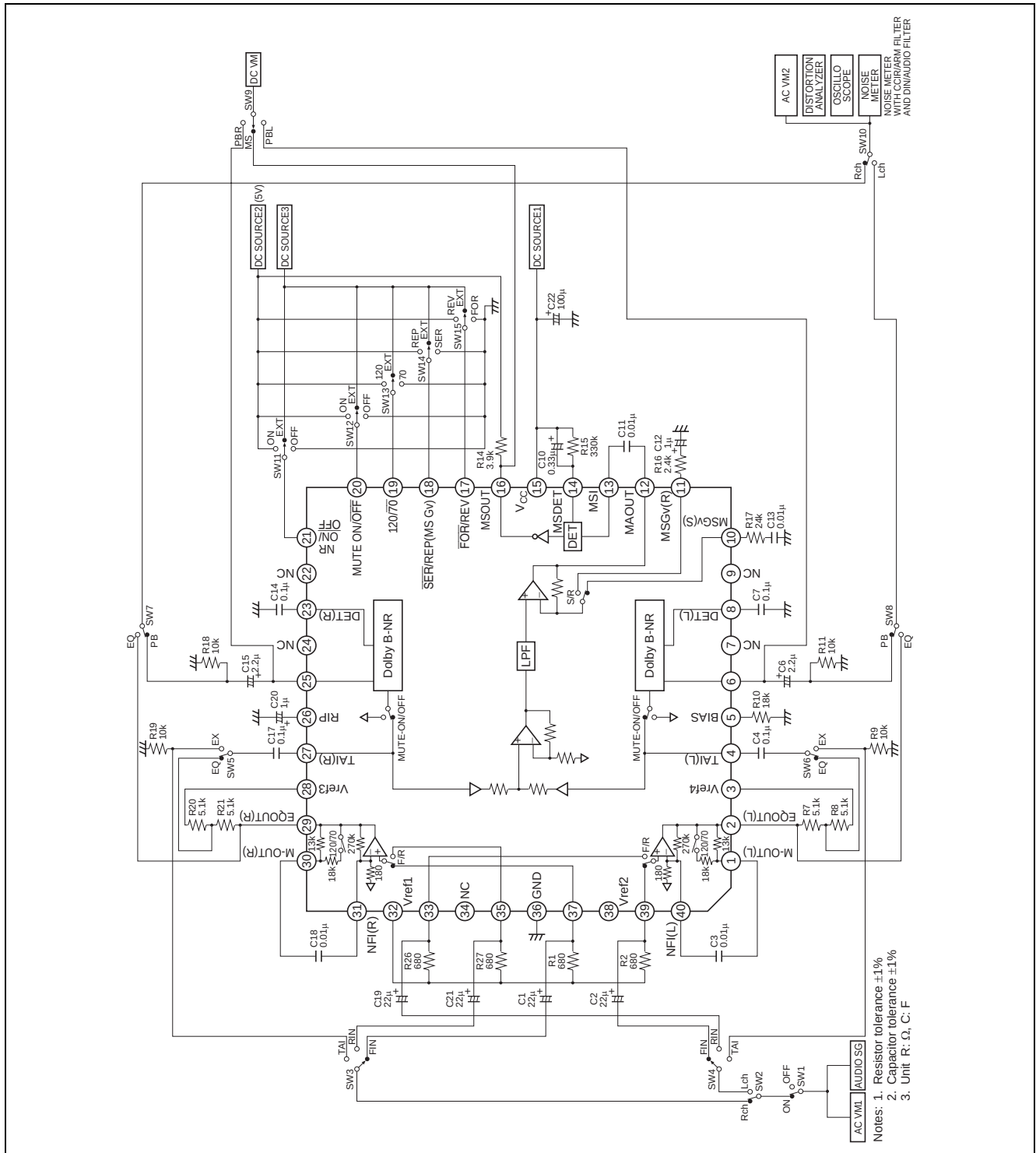
(Ta = 25°C, V_{CC} = 9 V, PBOUT level 0 dB = 300 mVrms, EQOUT level 0 dB = 60 mVrms)

Item	Symbol	Test Condition										Specification				Application Terminal			
		IC Condition				fin (Hz)	PBOUT level (dB)	EQOUT level (dB)	Other	Unit	Min	Typ	Max	Input		Output		COM	Remark
		MUTE ON/OFF	120μ/ 70μ	SER/ REP	FOR/ REV									R	L	R	L		
Quiescent current	I _Q	OFF	70μ	SER	FOR	—	—	—	No signal	mA	3.0	5.0	8.0	—	—	—	—	15	
Input Amp. gain	G _V /A	OFF	—	—	—	1k	0	—	—	dB	19.0	20.0	21.0	27	4	25	6		
PBOUT offset	V _{ofs}	OFF→ ON	—	—	—	—	—	—	No signal	mV	-150	0	150	—	—	25	6	1	
Signal handling	V _{o max}	OFF	—	—	—	1k	—	—	THD=1%	dB	12.0	13.0	—	27	4	25	6	2	
Signal to noise ratio	S/N	OFF	—	—	—	1k	(0)	—	Rg=10kΩ, CCIR/ARM	dB	70.0	80.0	—	27	4	25	6		
Total Harmonic Distortion	THD	OFF	—	—	—	1k	0	—	—	%	—	0.05	0.3	27	4	25	6		
Channel separation	CTRL (1)	—	—	—	FOR	1k	—	(+20)	—	dB	50.0	60.0	—	37	39	29→2	2→29		
	CTRL (2)	OFF	—	—	—	1k	(+12)	—	—	dB	70.0	80.0	—	27	4	25→6	6→25		
MUTE attenuation	CT MUTE	OFF→ ON	—	—	—	1k	(+12)	—	—	dB	70.0	80.0	—	27	4	25	6		
PB-EQ gain	G _V EQ 1k	—	120μ	—	FOR/ REV	1k	—	0	—	dB	37.8	40.8	43.8	37/35	39/33	29	2		
	G _V EQ 10k(1)	—	120μ	—	FOR	10k	—	0	—	dB	33.9	36.9	39.9	37	39	29	2		
	G _V EQ 10k(2)	—	70μ	—	FOR	10k	—	0	—	dB	29.6	32.6	35.6	37	39	29	2		
PB-EQ Maximum output level	V _{OM}	—	120μ	—	FOR	1k	—	—	THD=1%	mVrms	300	600	—	37	39	29	2		
PB-EQ T.H.D.	THD-EQ	—	120μ	—	FOR/ REV	1k	—	+14dB	—	%	—	0.1	0.3	37/35	39/33	29	2		
PB-EQ input conversion noise	V _N	—	120μ	—	FOR/ REV	(1k)	—	—	Rg=680Ω, DIN-AUDIO	μVrms	—	0.7	1.5	37/35	39/33	29	2		
MS sensing level	V _{ON} (1)	OFF	—	SER	—	5k	—	—	—	dB	-36.0	-32.0	-28.0	27	4	25	6	16	3
	V _{ON} (2)	OFF	—	REP	—	5k	—	—	—	dB	-18.0	-14.0	-10.0	27	4	25	6	16	3
MS output low level	V _{OL}	OFF	—	SER	—	5k	0	—	—	V	—	1.0	1.5	27	4	—	—	16	
MS output leakage current	I _{OH}	—	—	—	—	—	—	—	No signal	μA	—	0.0	2.0	—	—	—	—	16	
Control voltage	V _{IL}	—	—	—	—	—	—	—	—	V	-0.2	—	1.0	—	—	—	—	17 to 20	
	V _{IH}	—	—	—	—	—	—	—	—	V	3.5	—	V _{CC}	—	—	—	—	—	

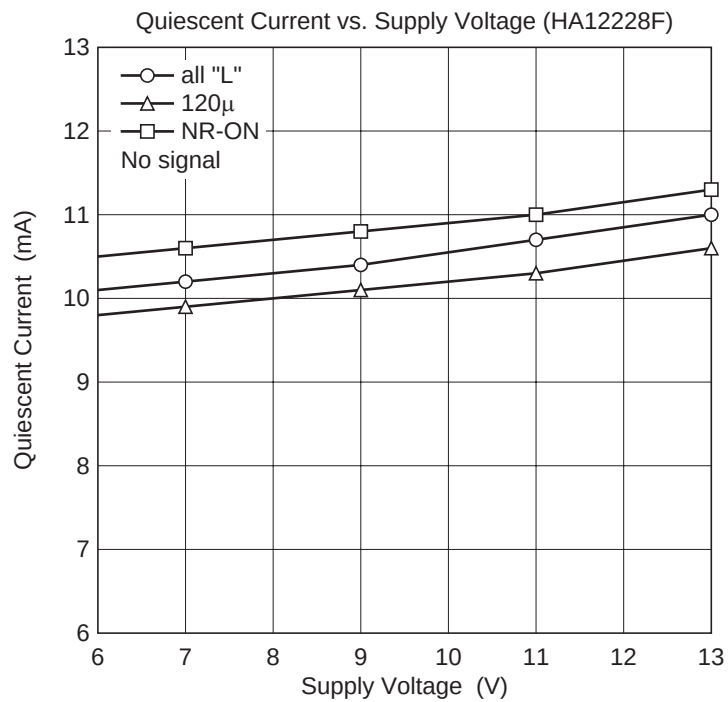
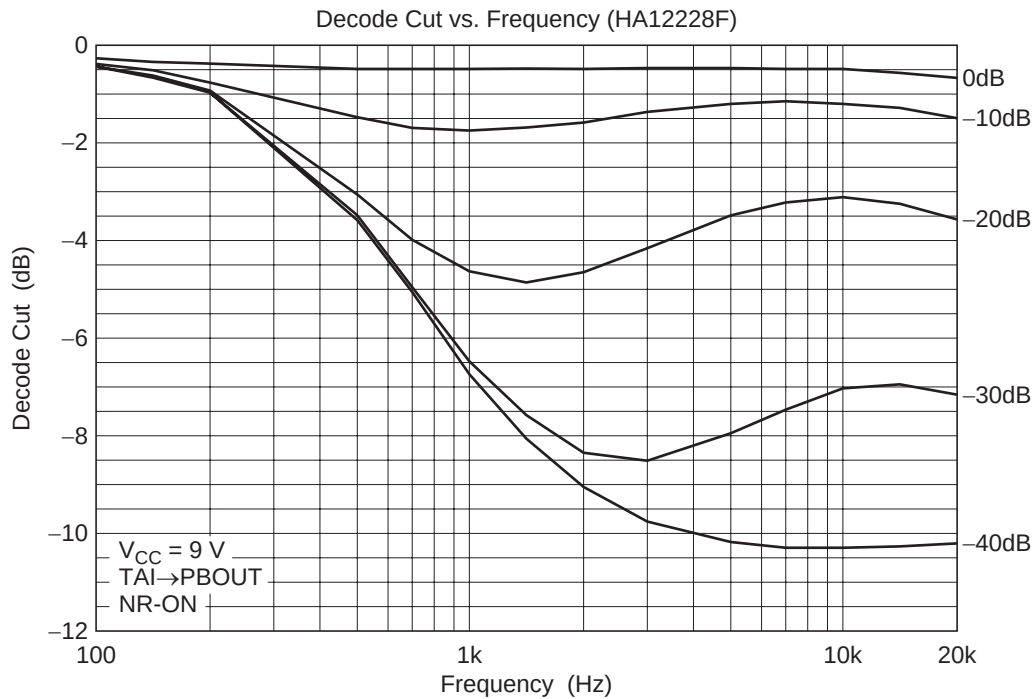
Notes: 1. V_{CC} = 12V2. V_{CC} = 6.5V

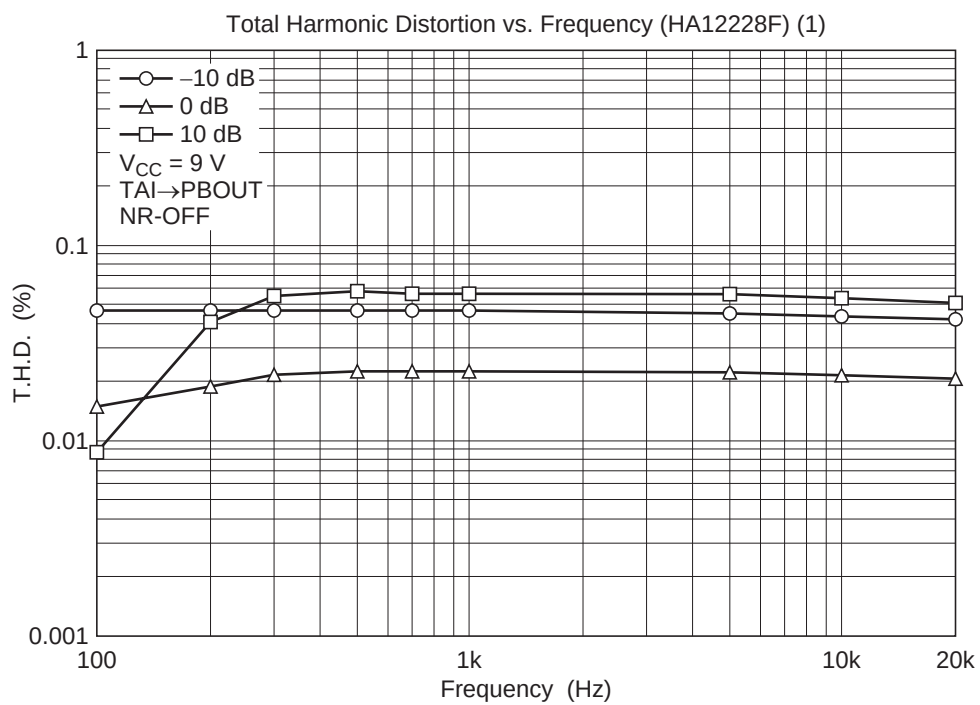
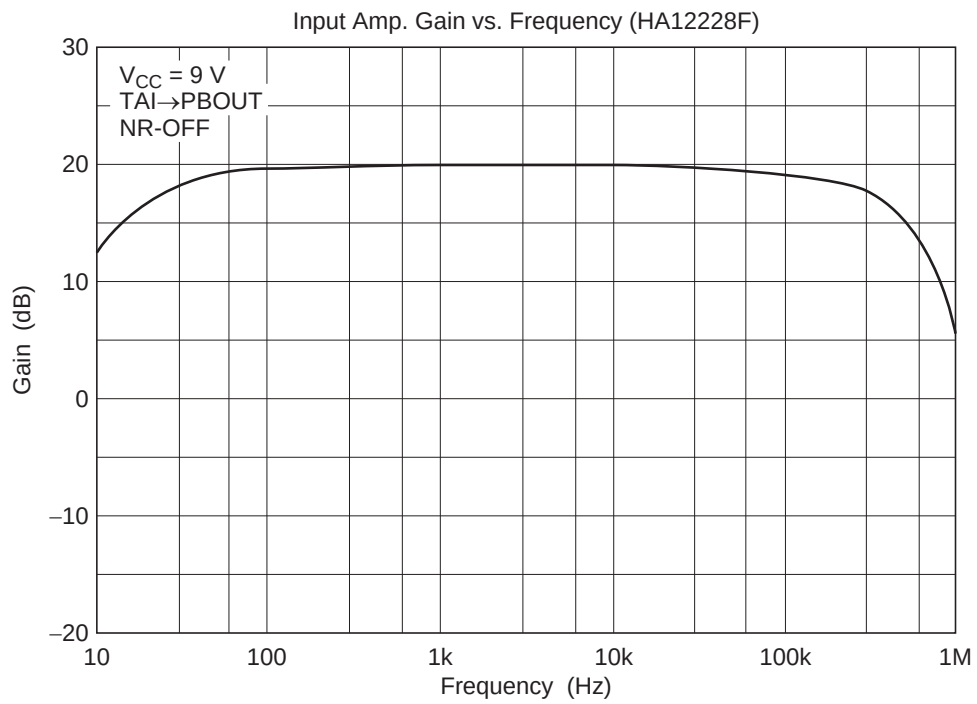
3. For inputting signal to one side channel

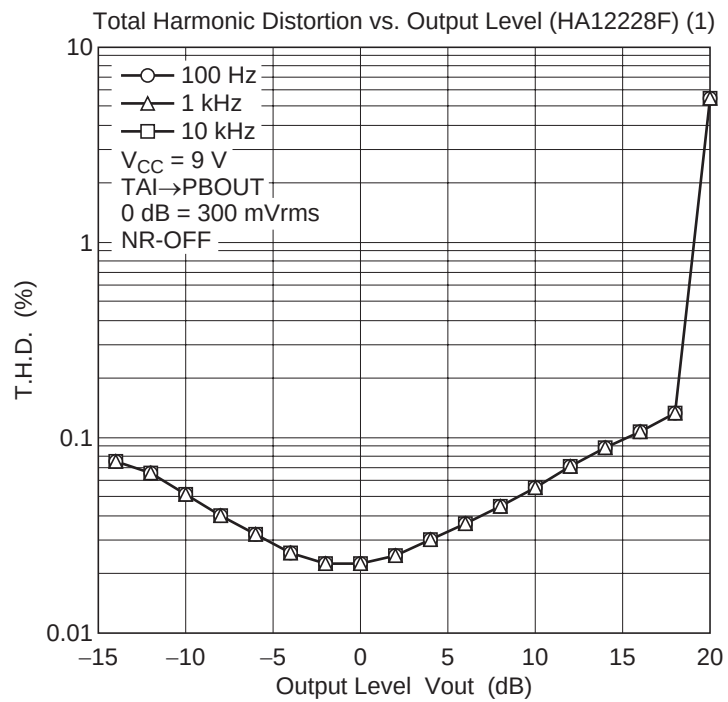
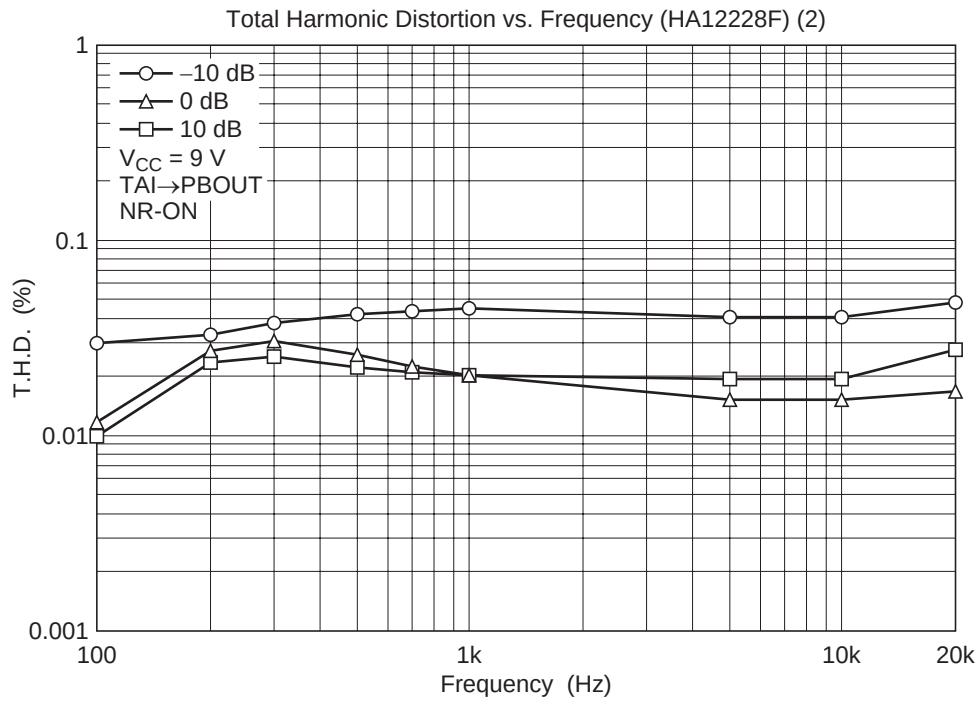
Test Circuit

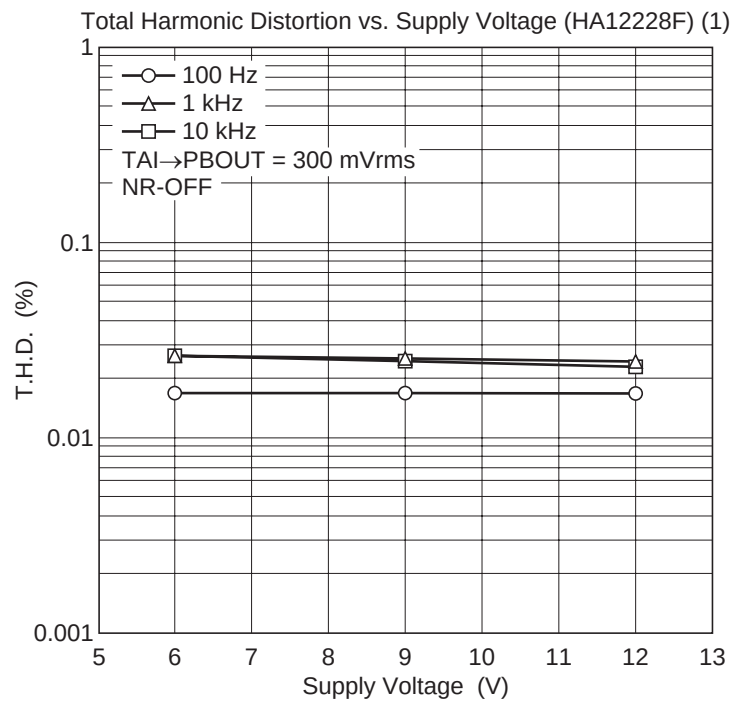
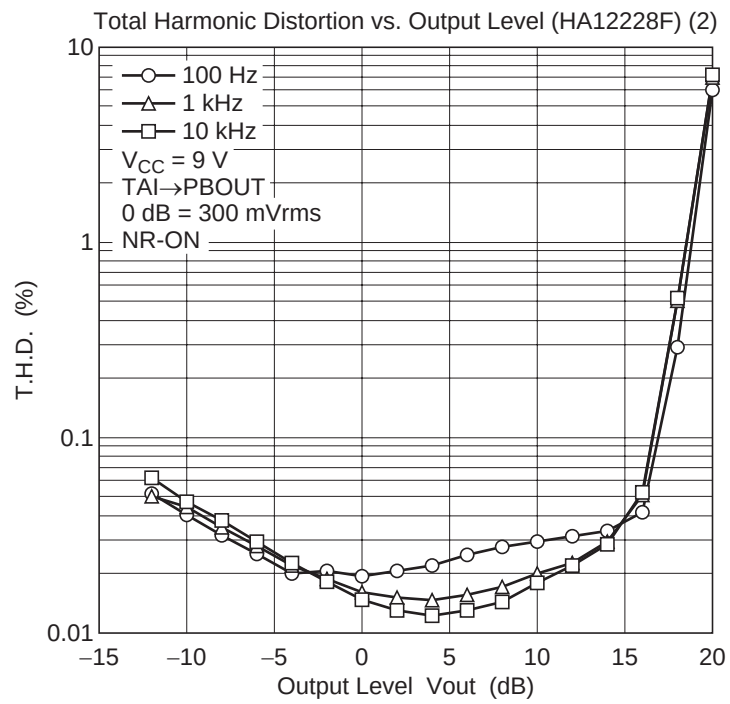


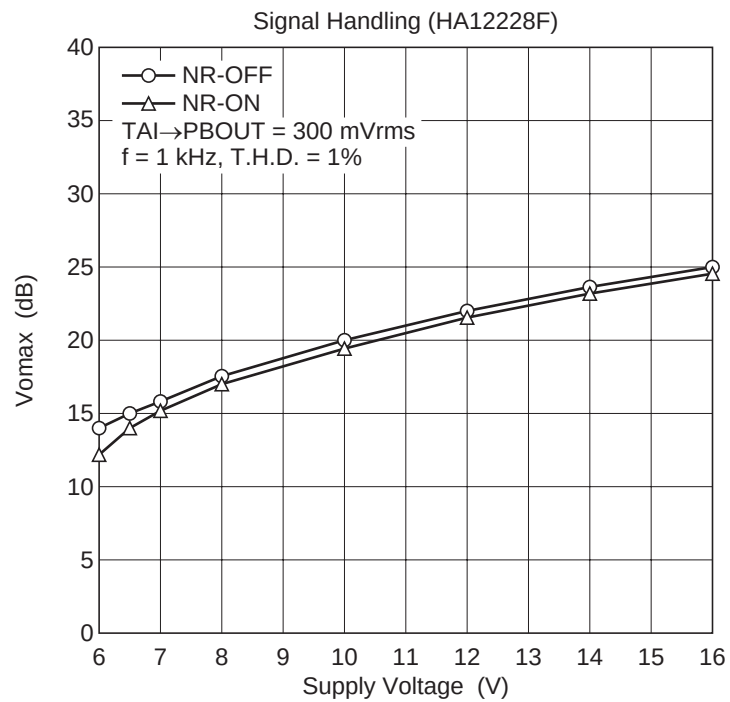
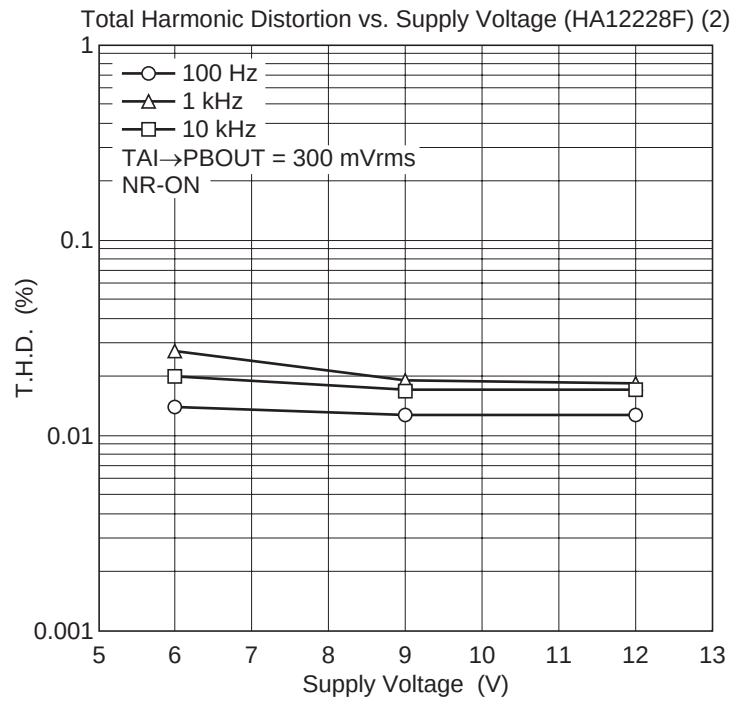
Characteristic Curves

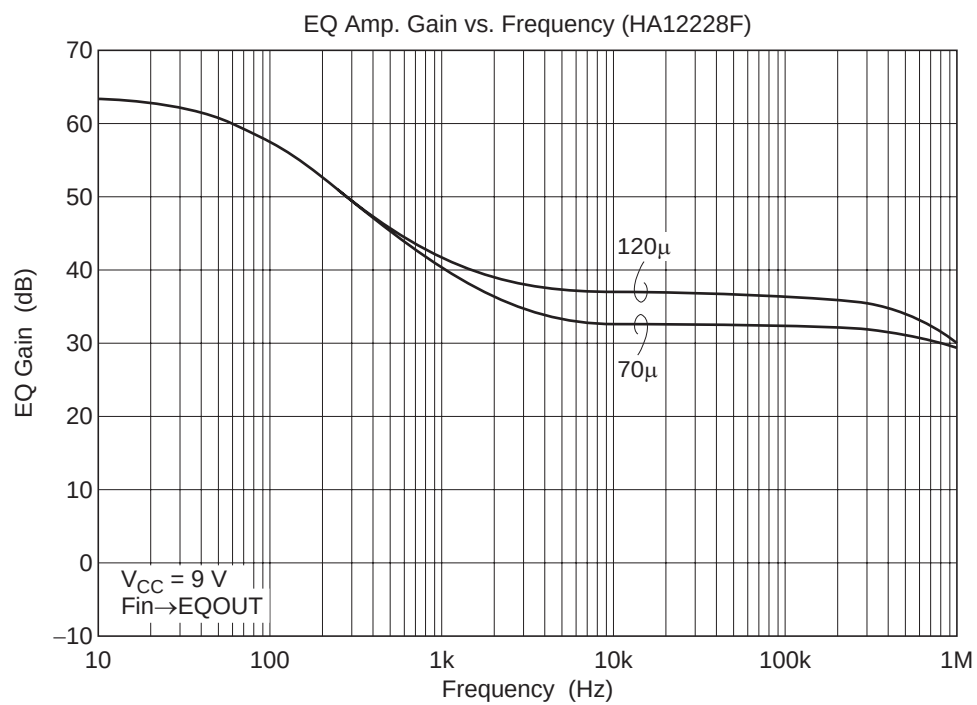
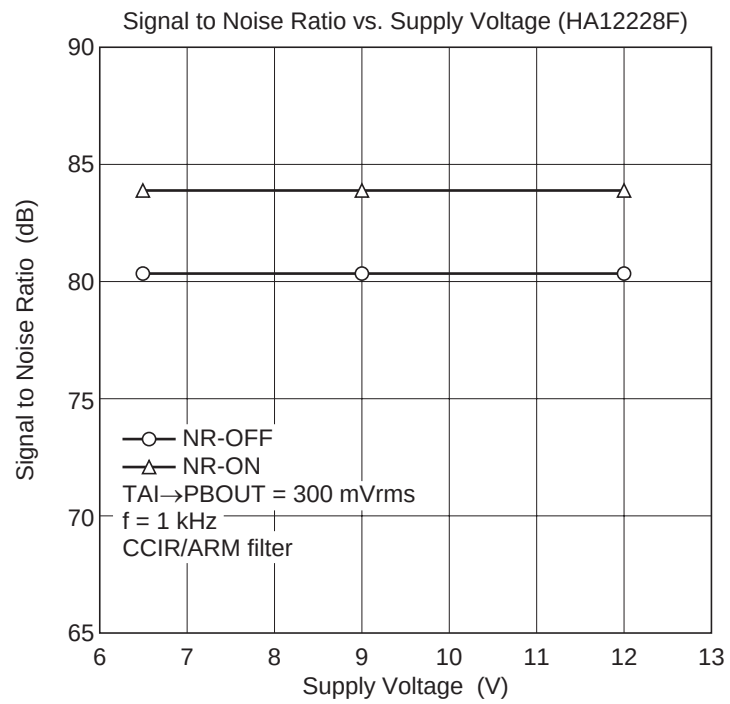


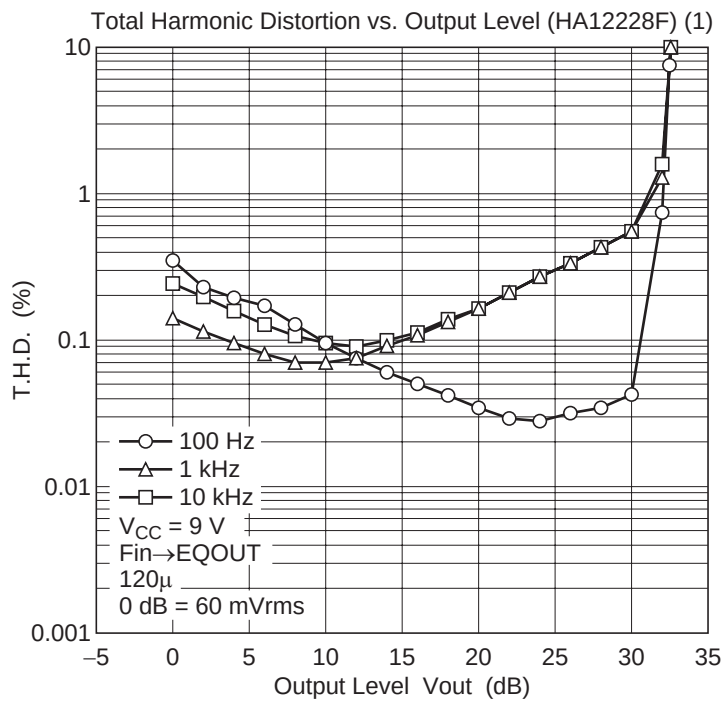
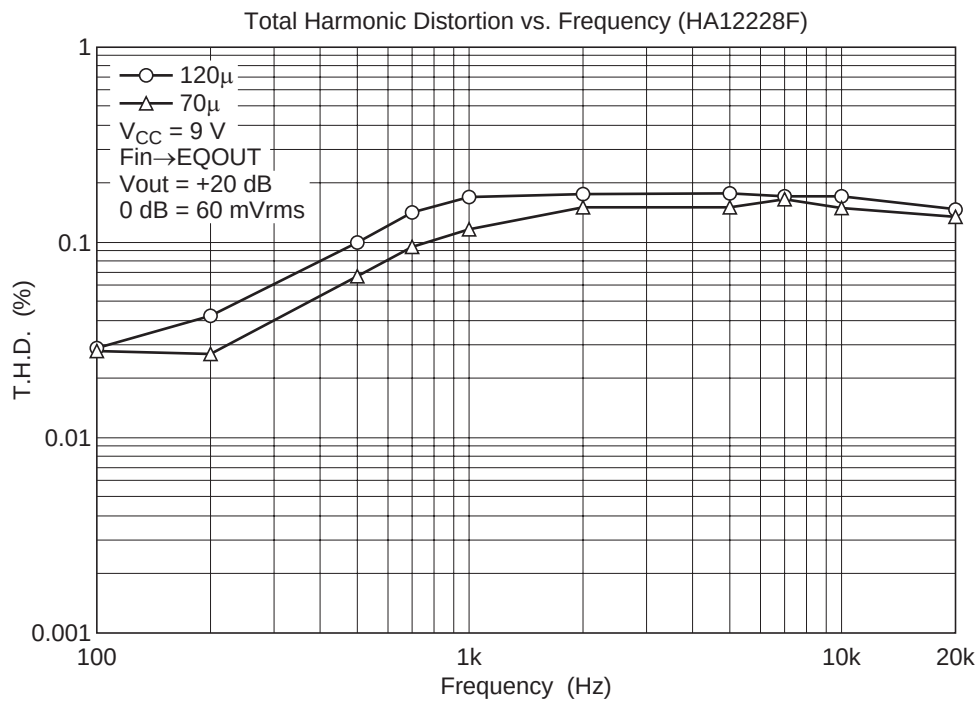


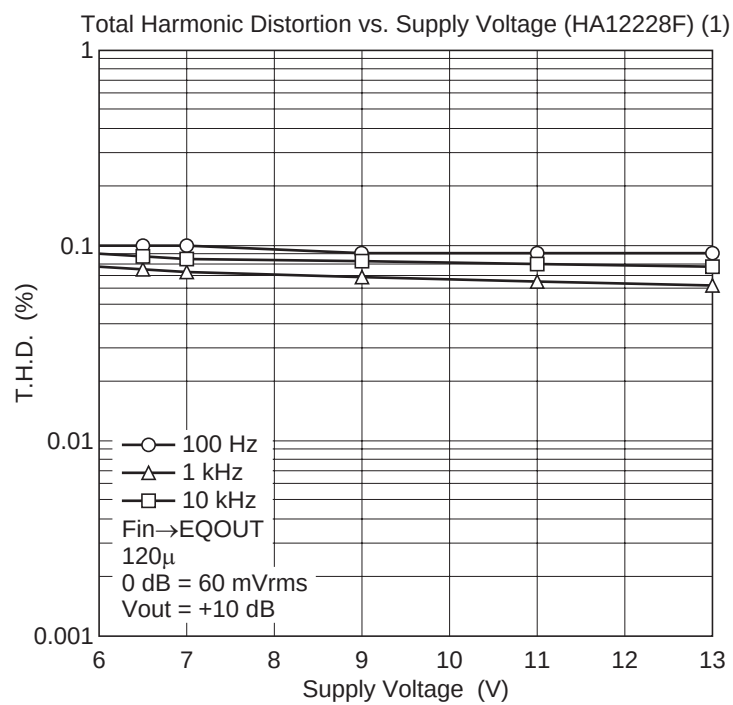
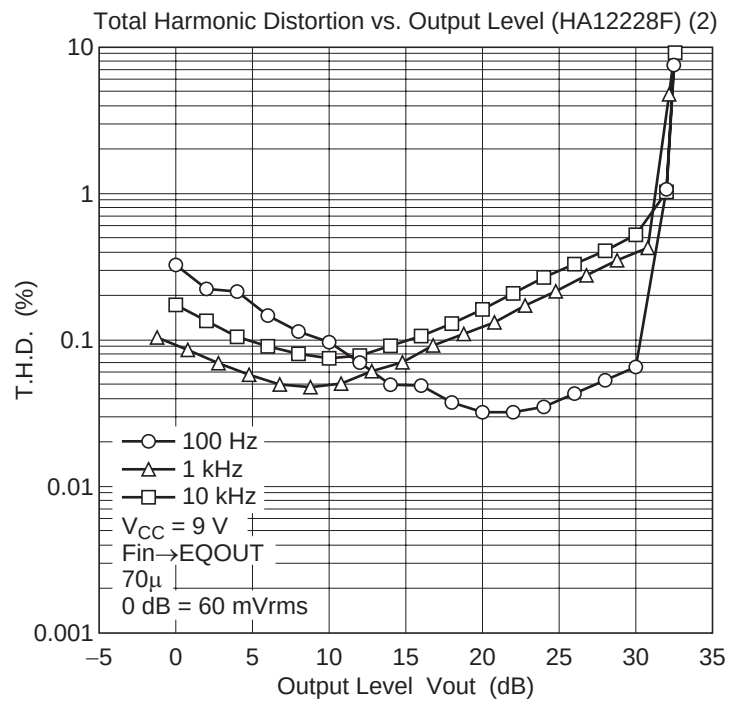


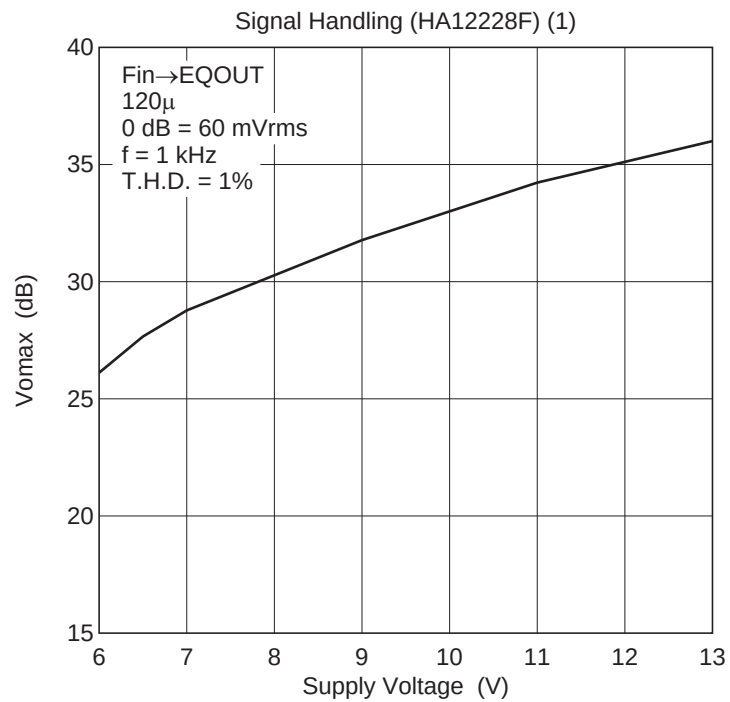
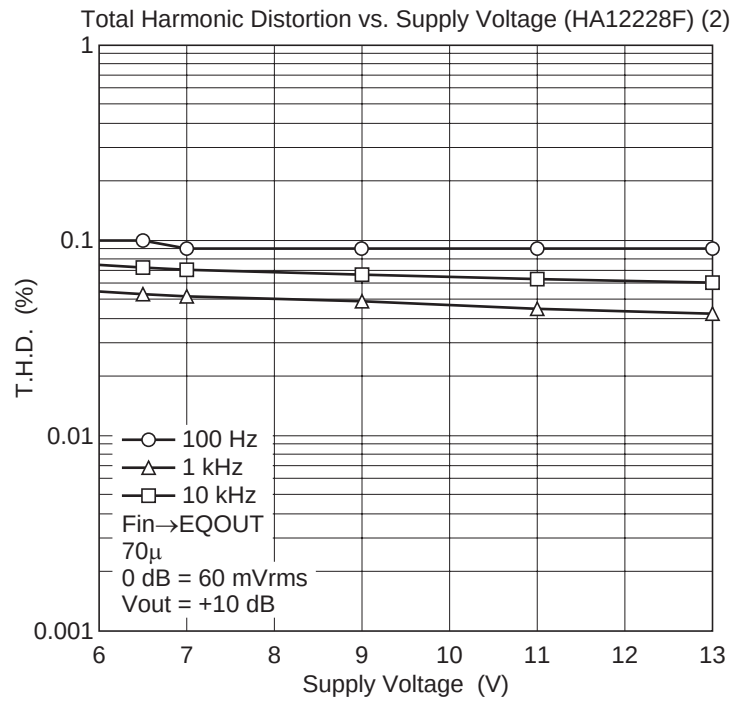


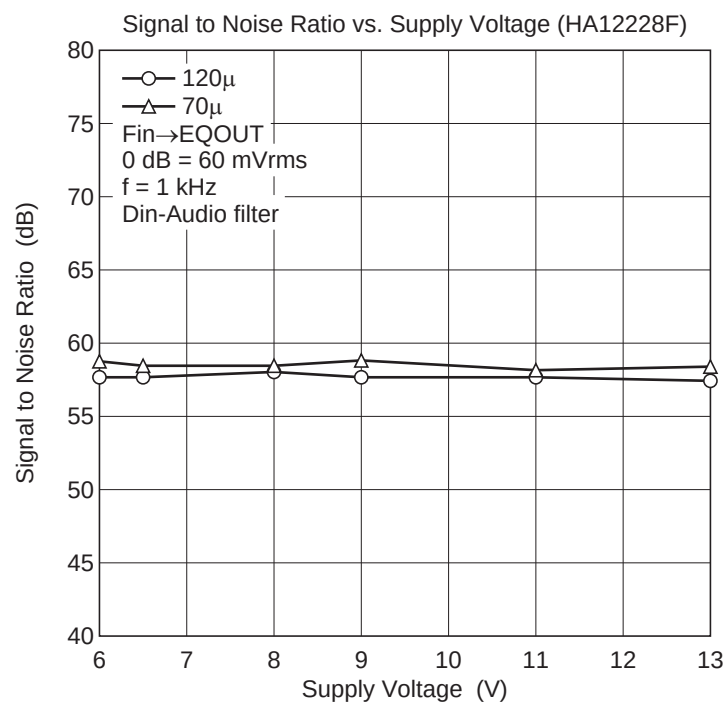
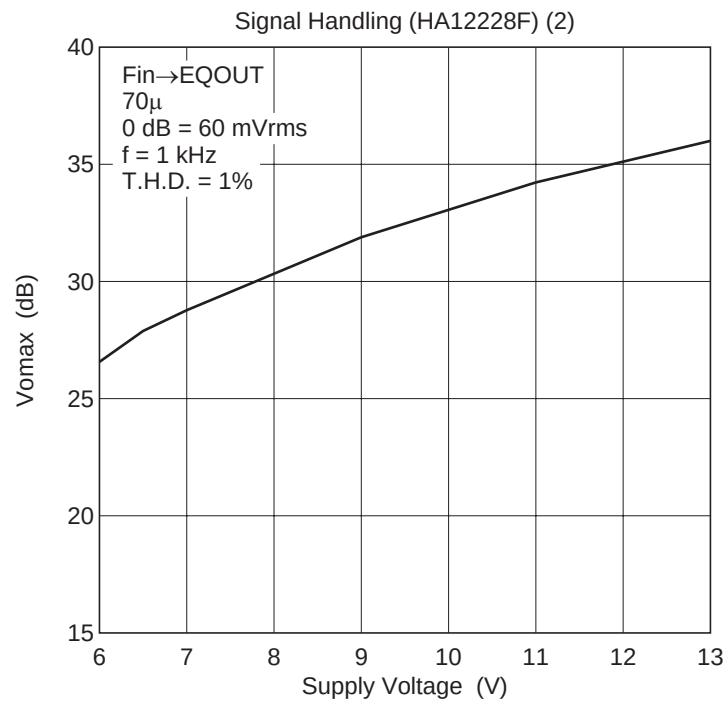


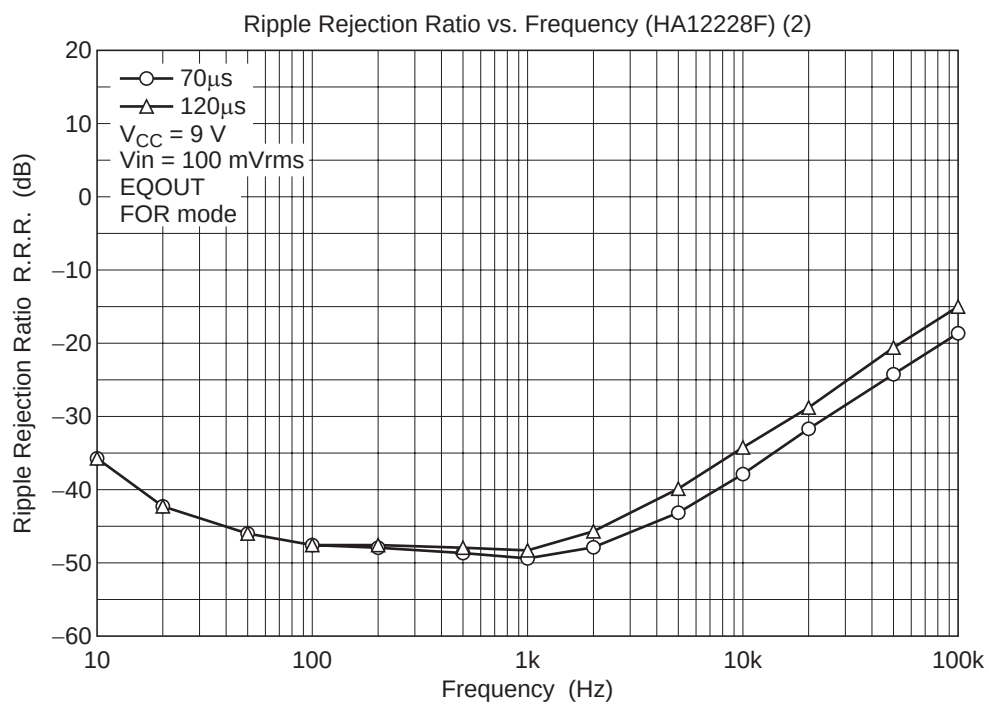
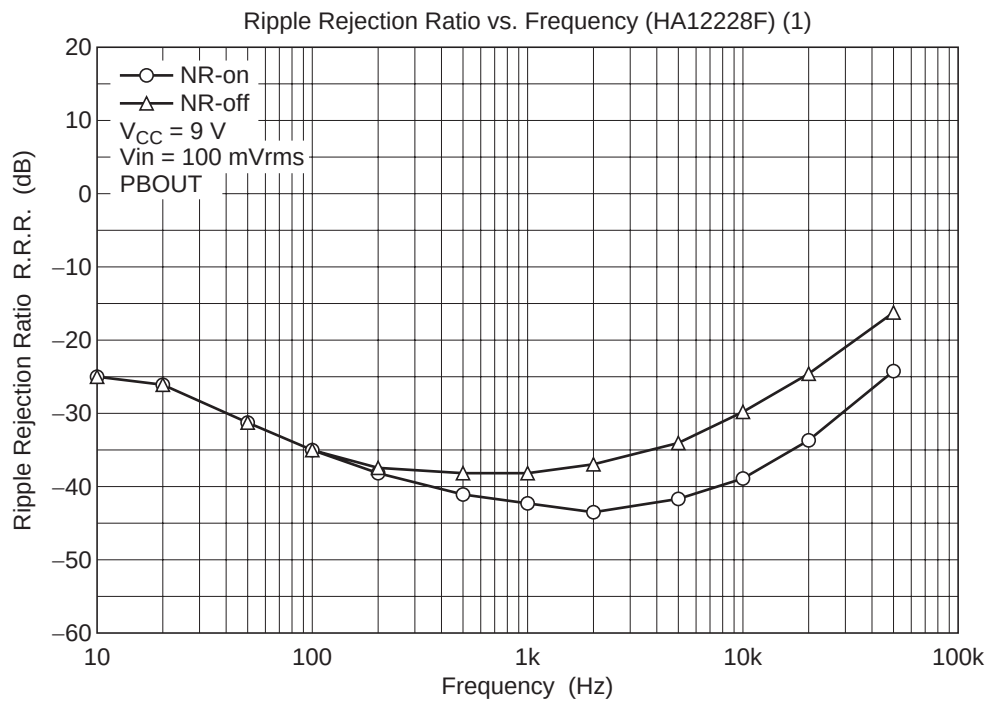


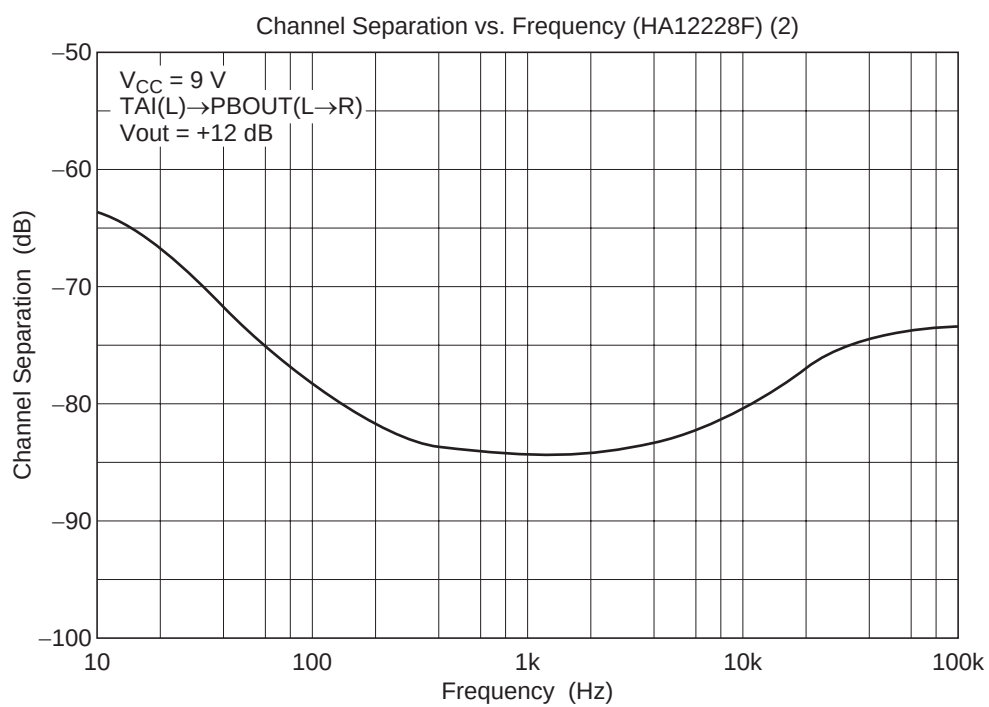
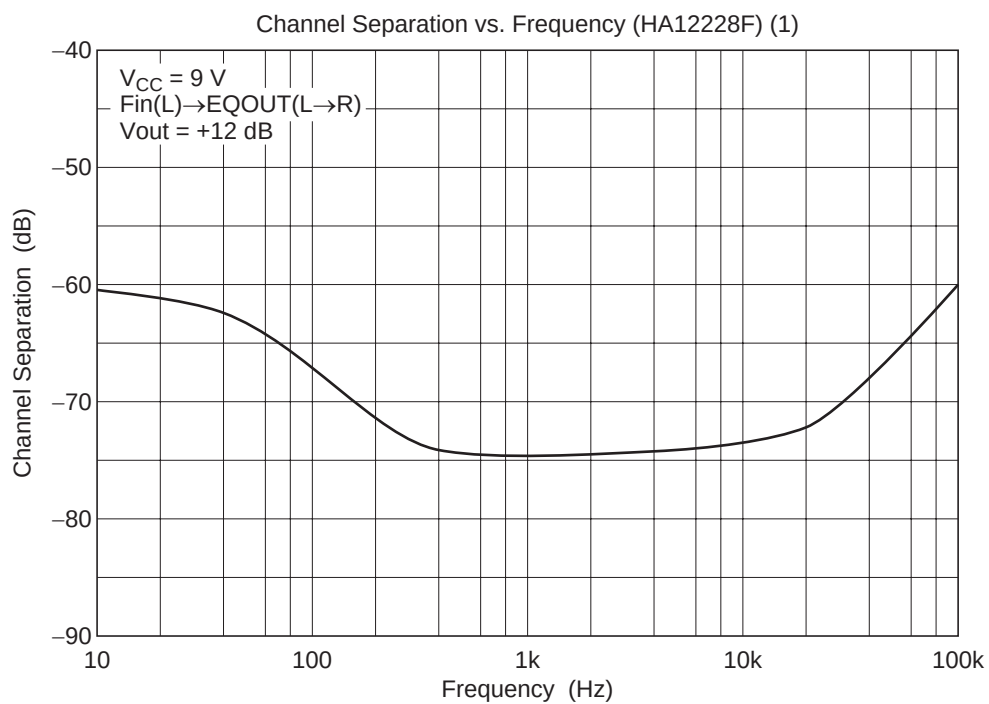


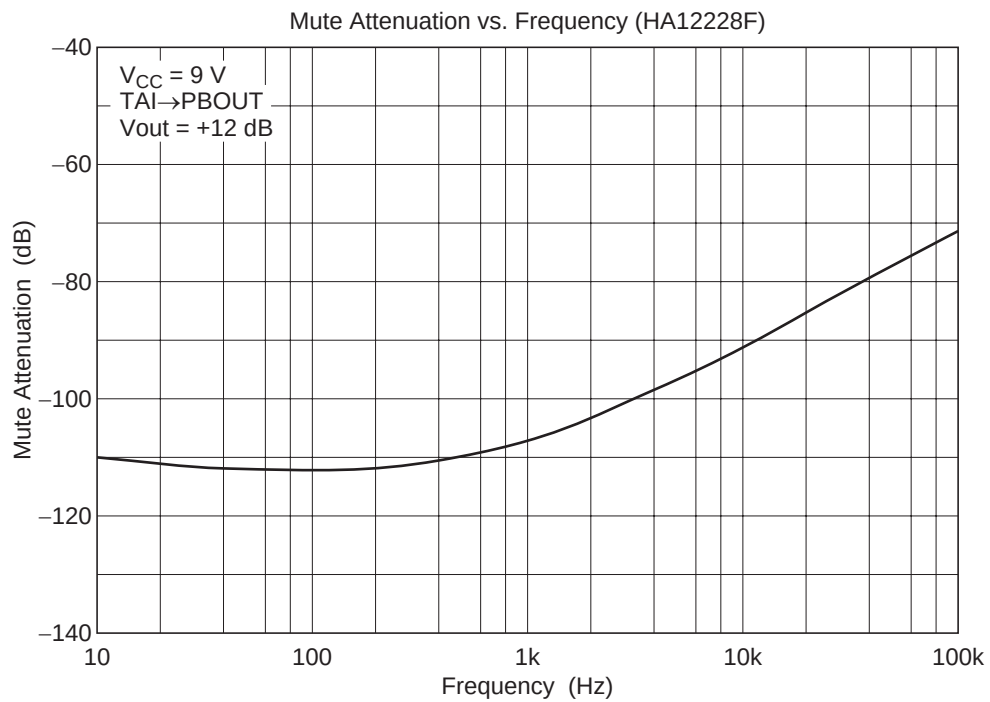
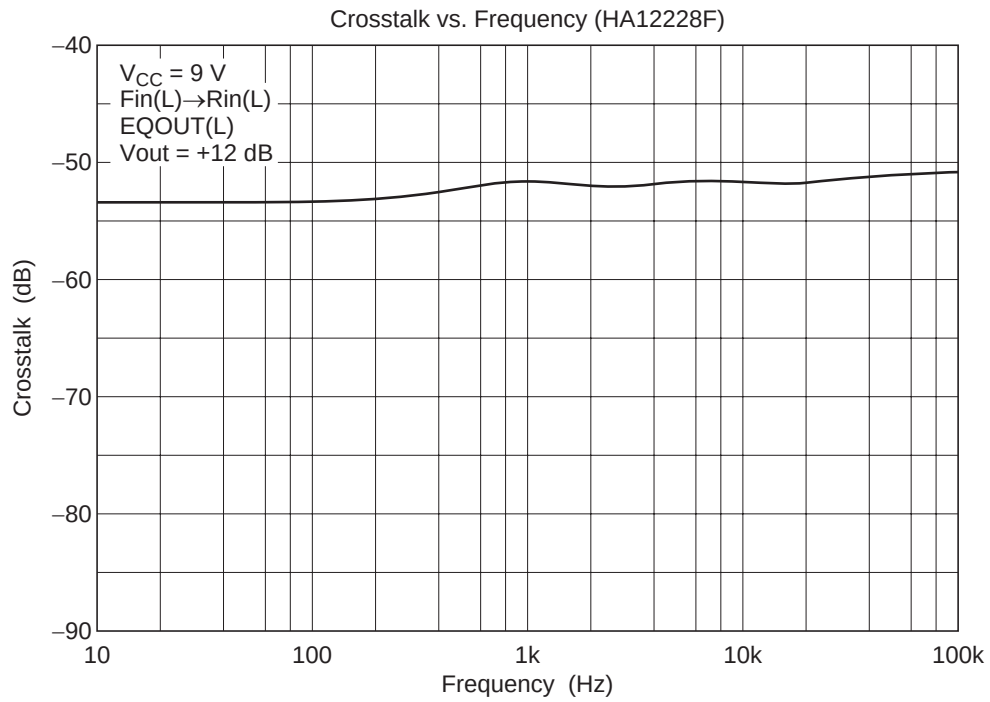


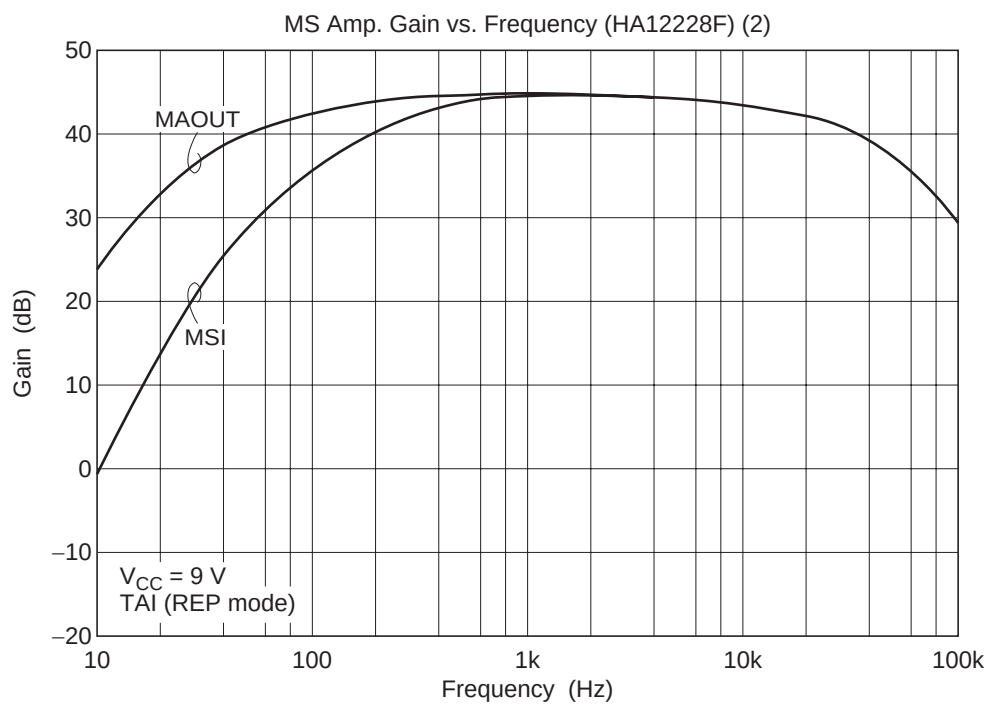
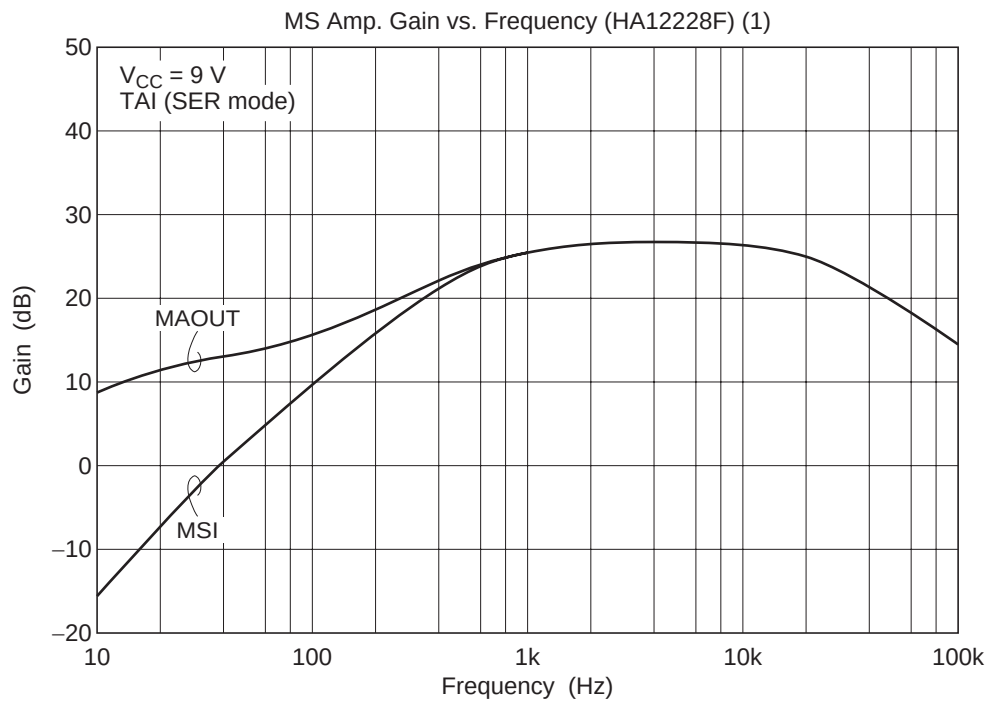


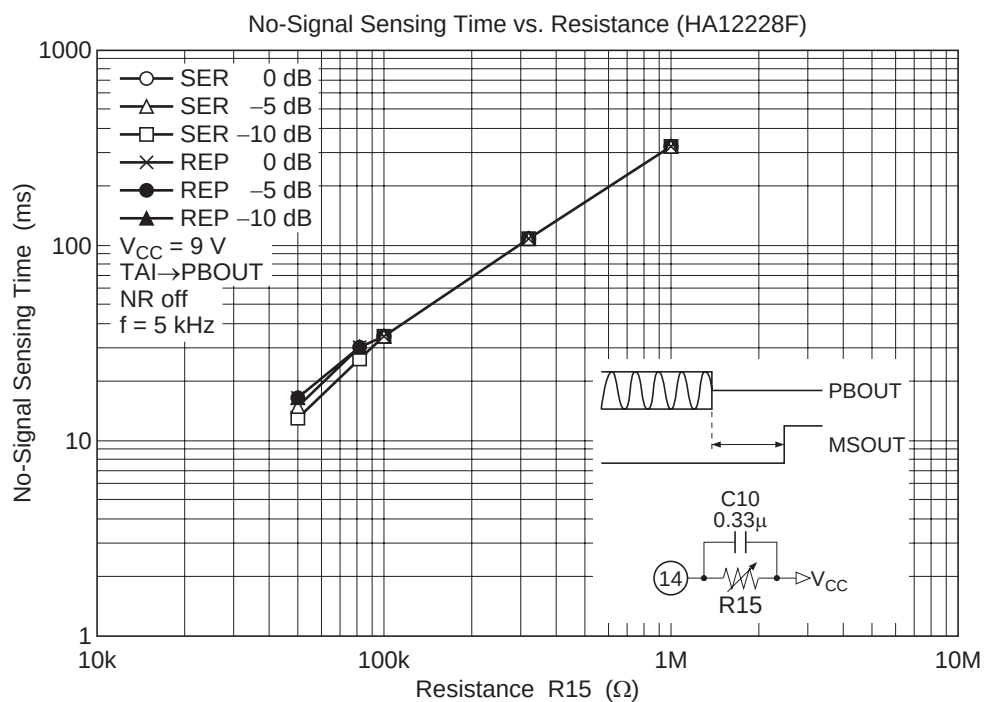
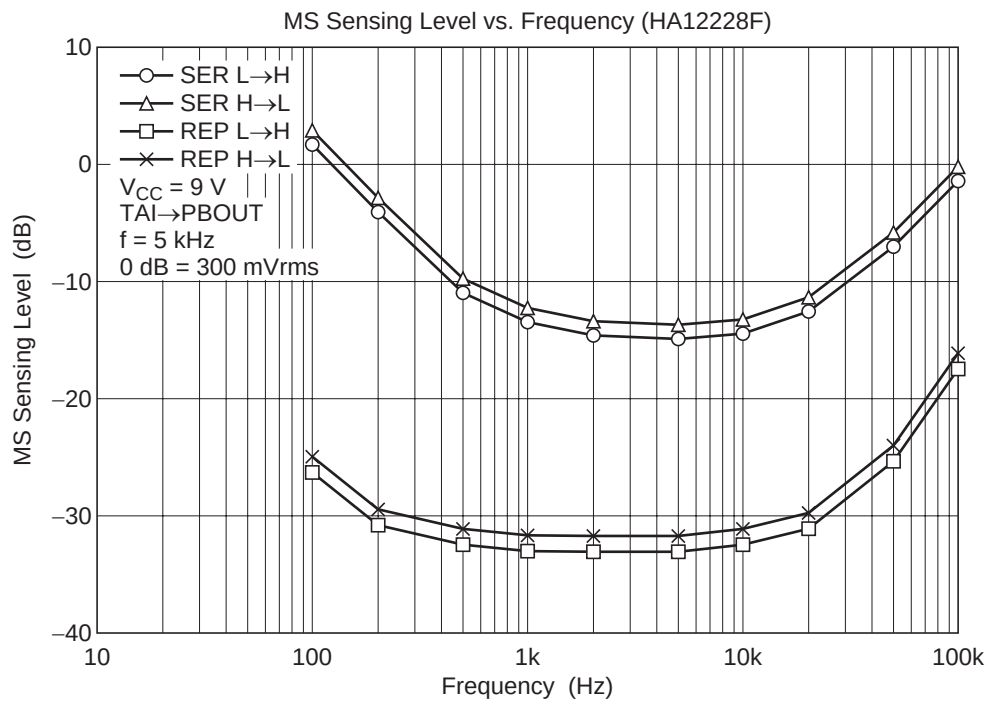


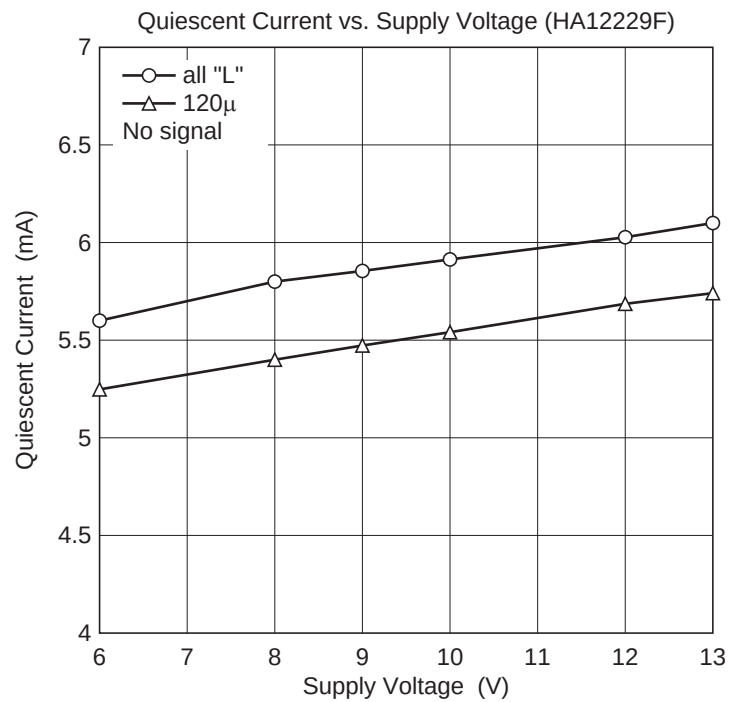
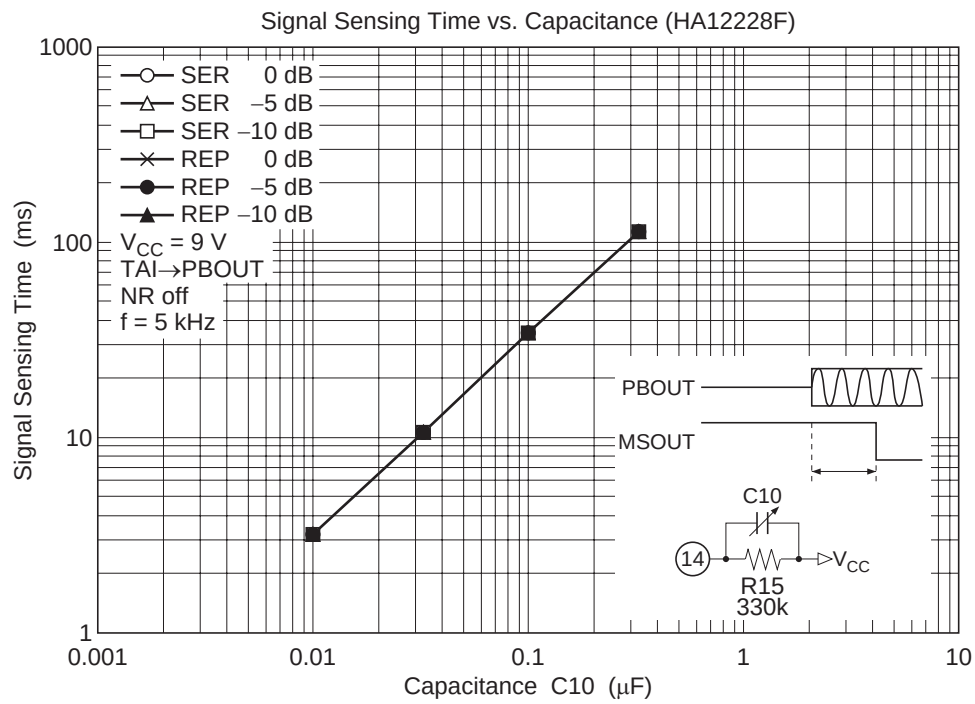


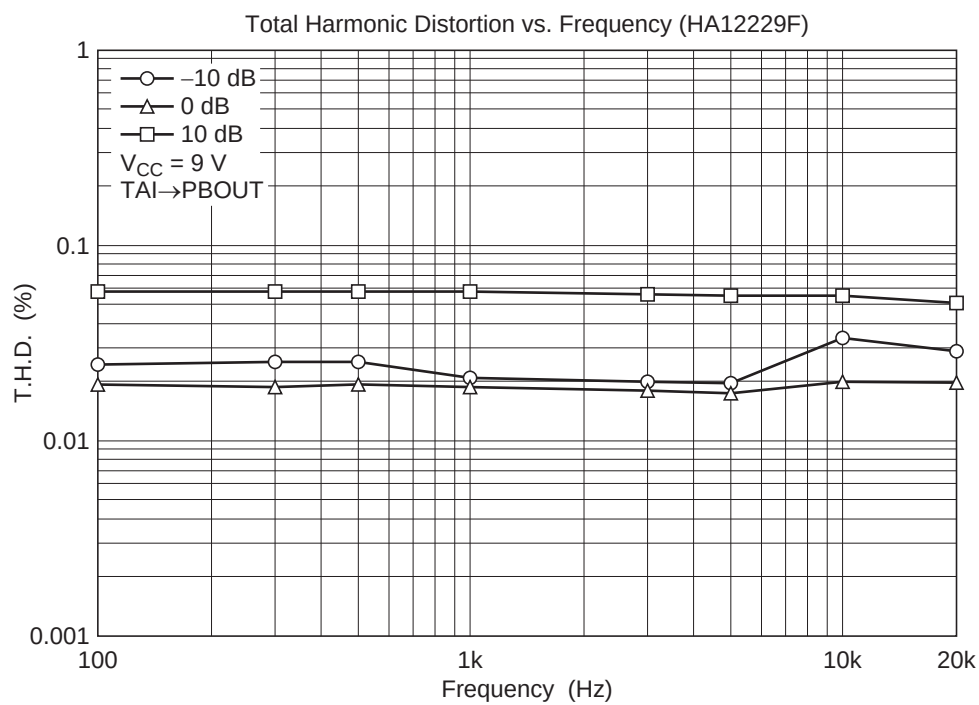
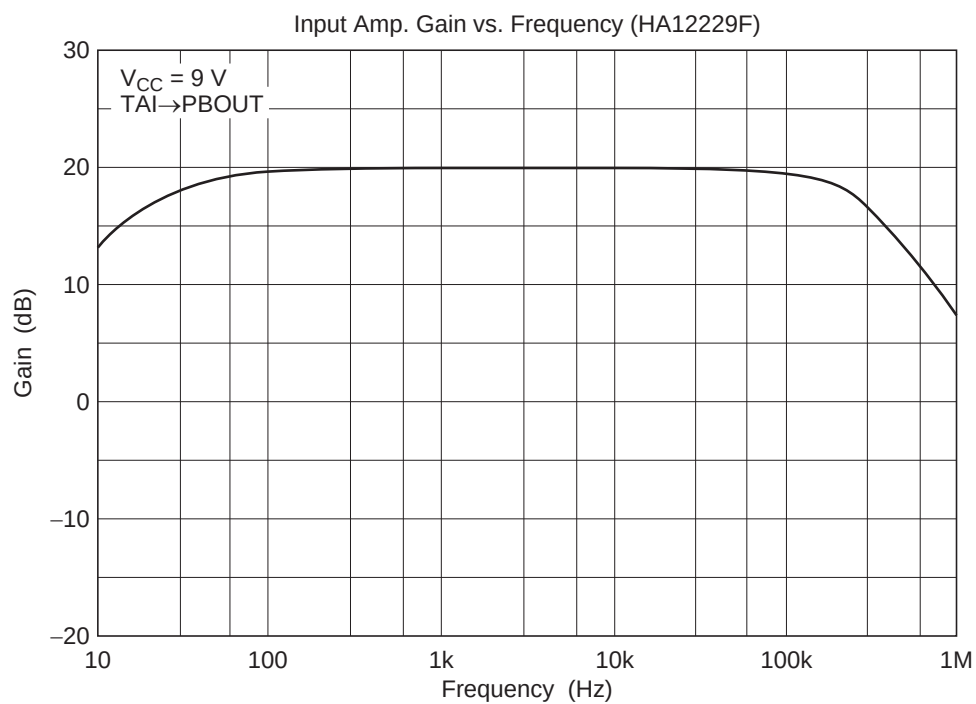


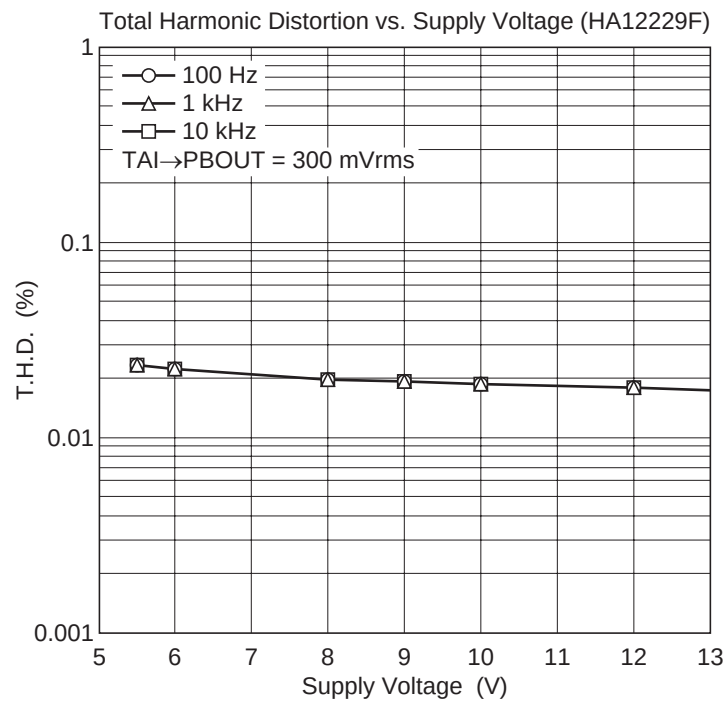
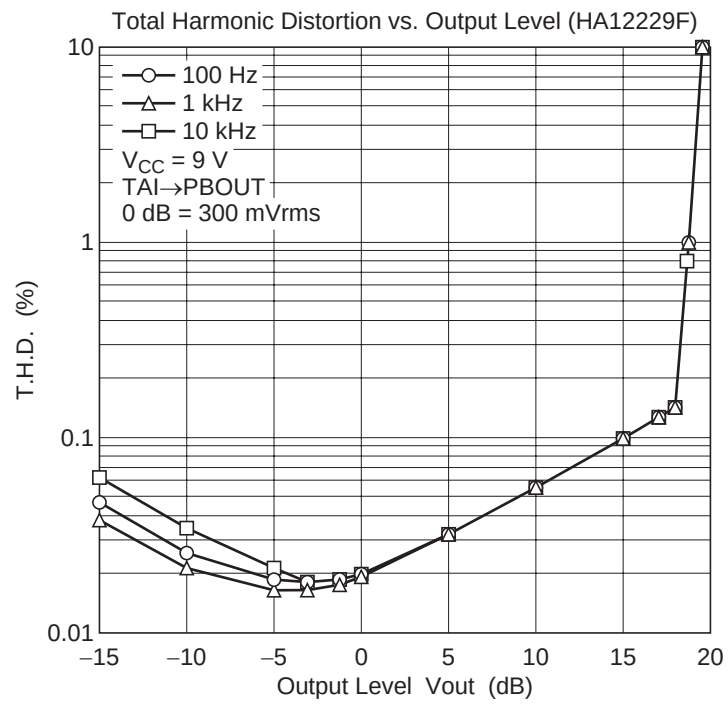


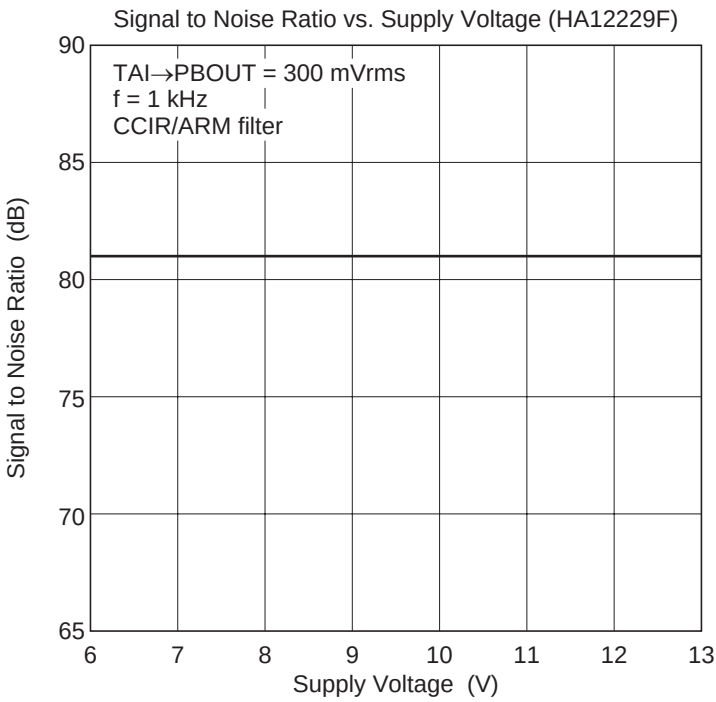
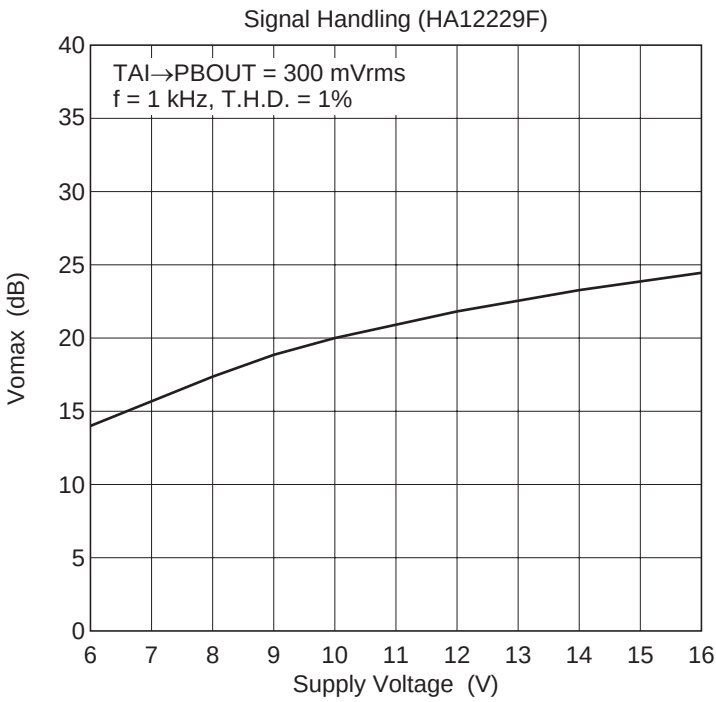


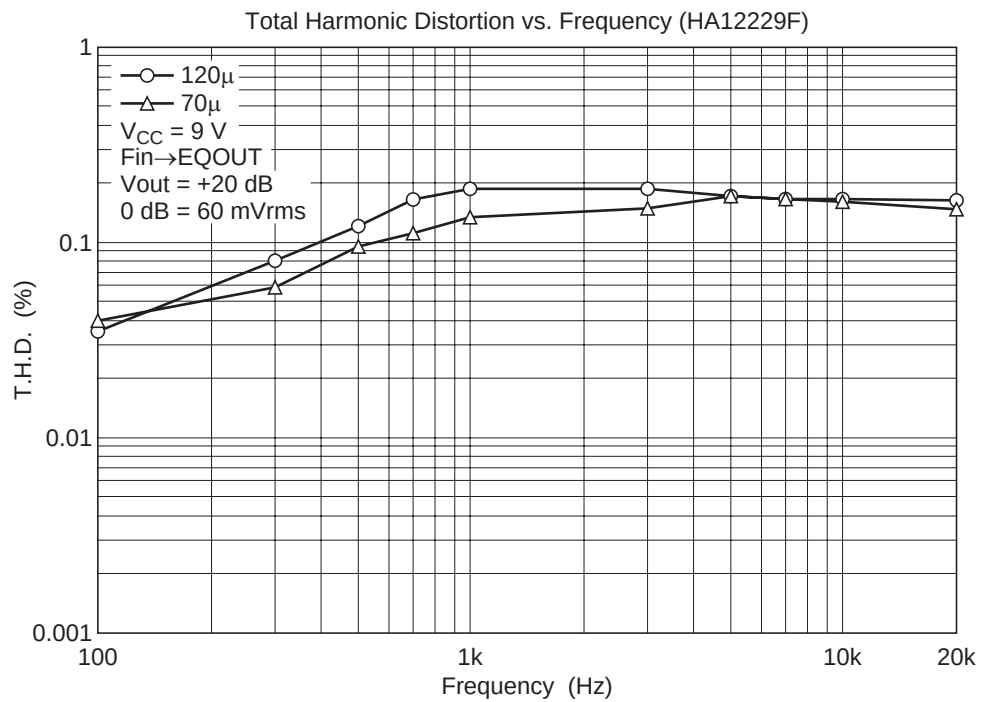
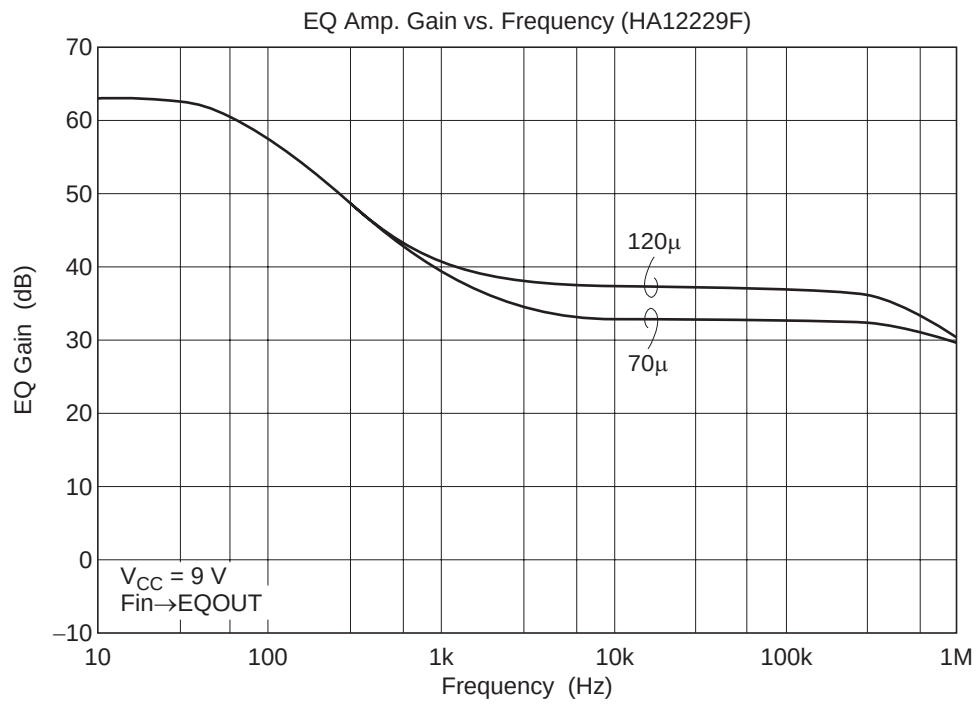


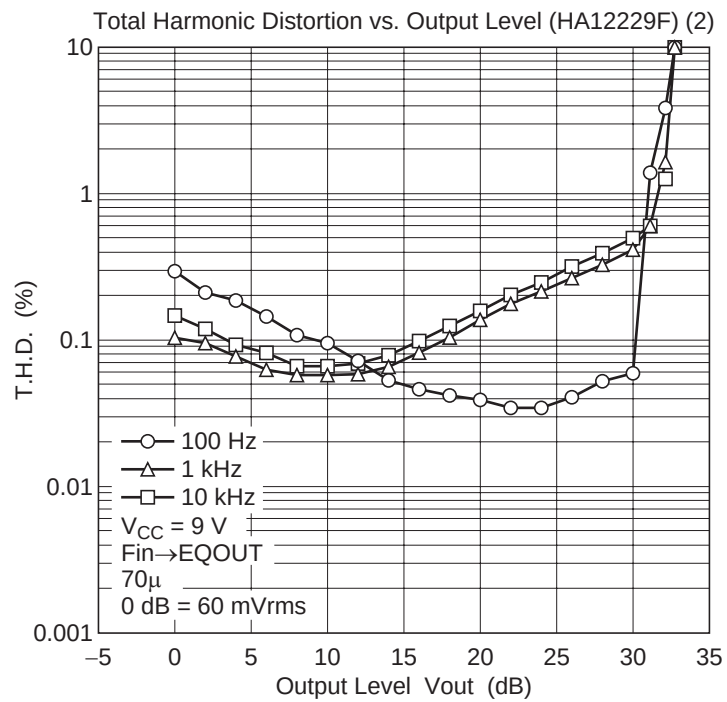
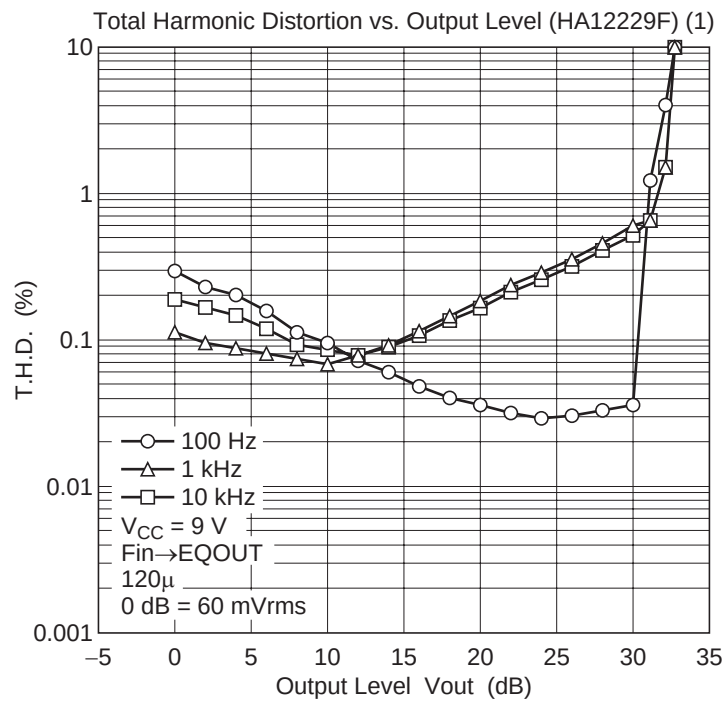


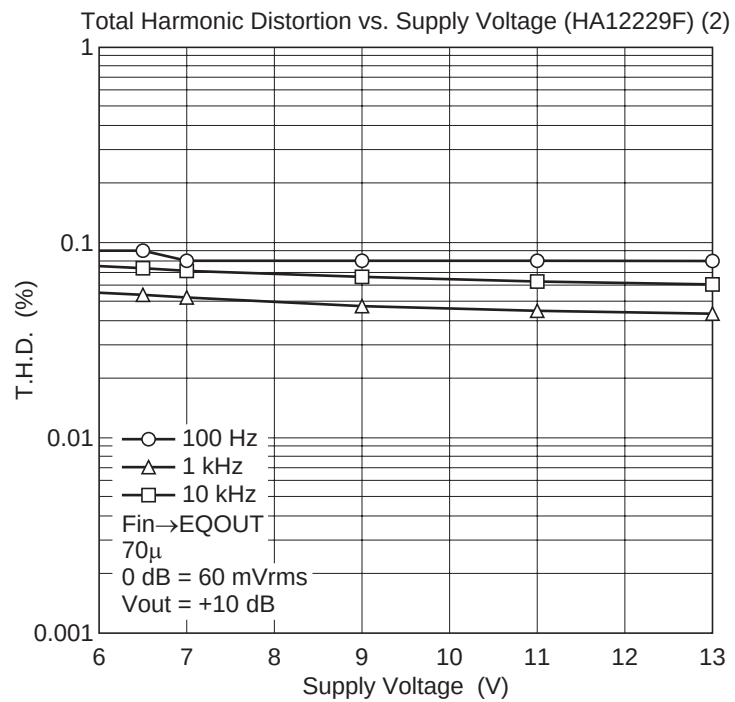
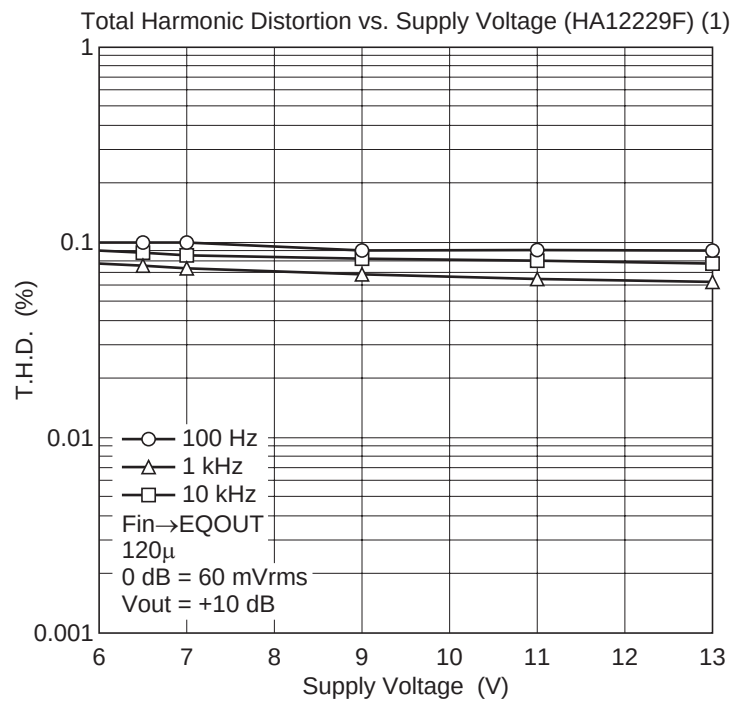


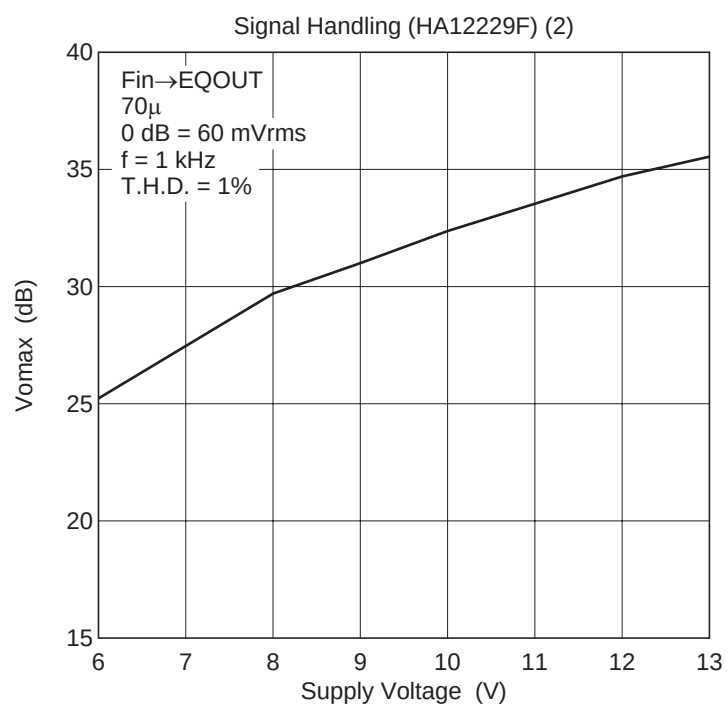
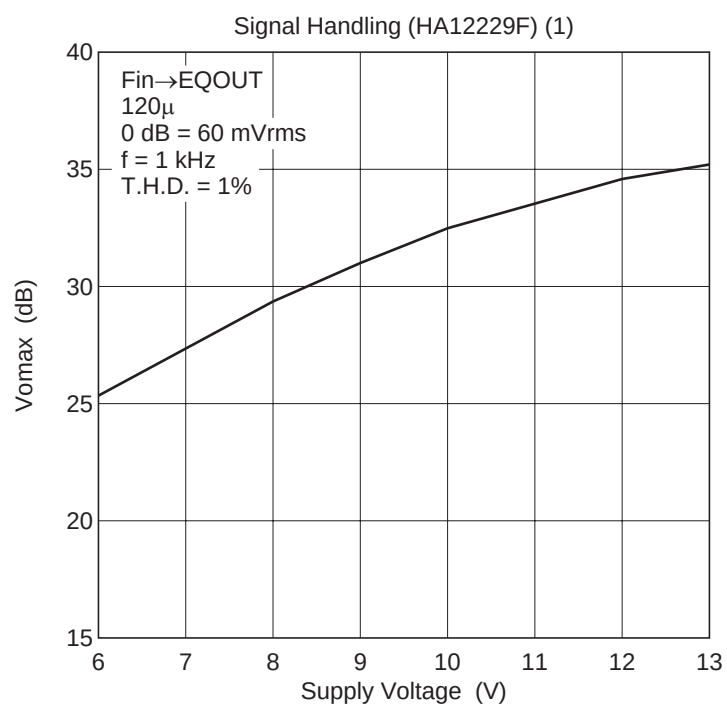


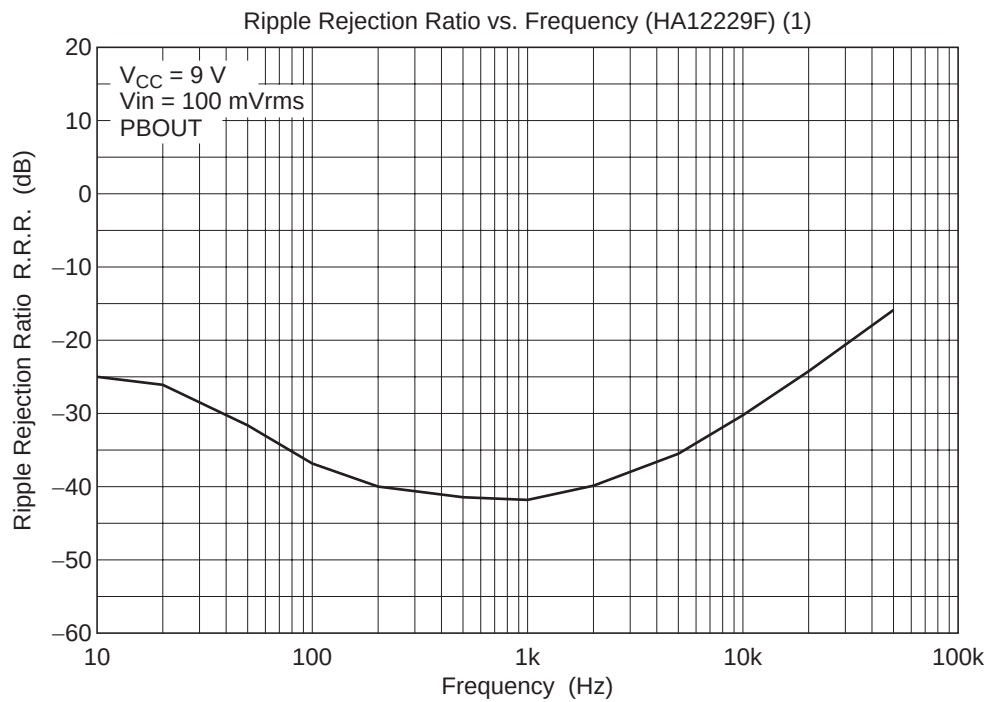
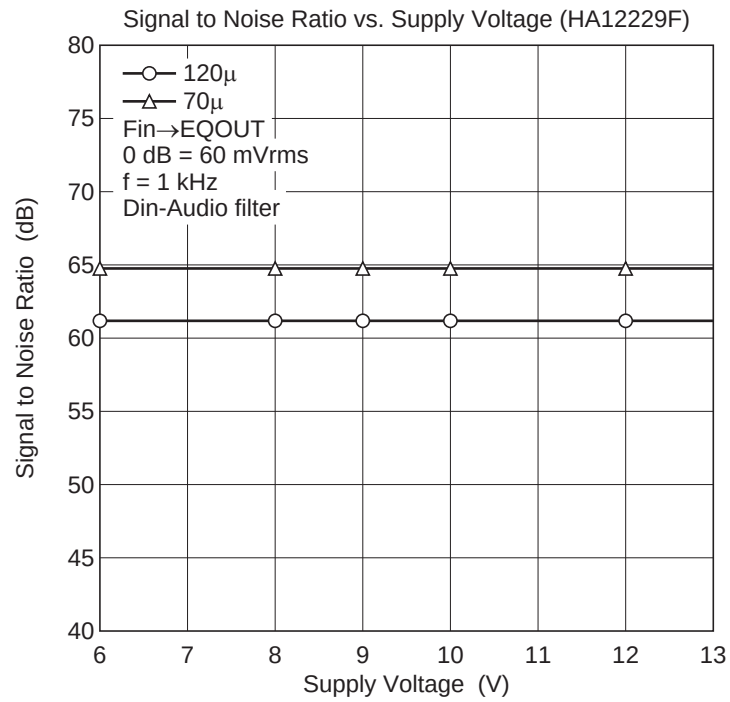


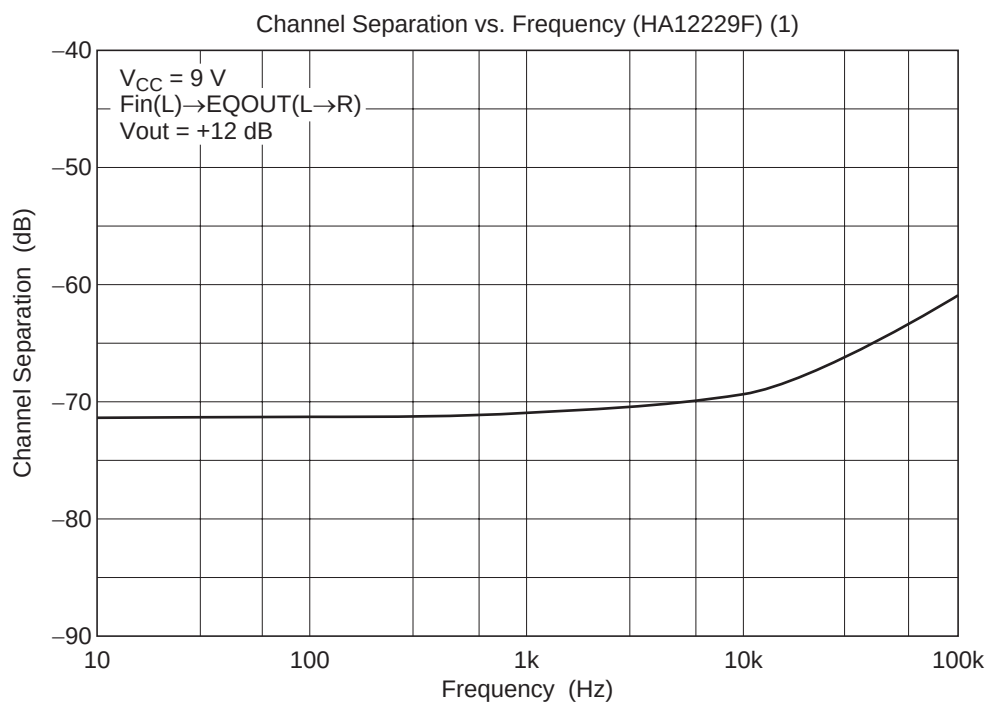
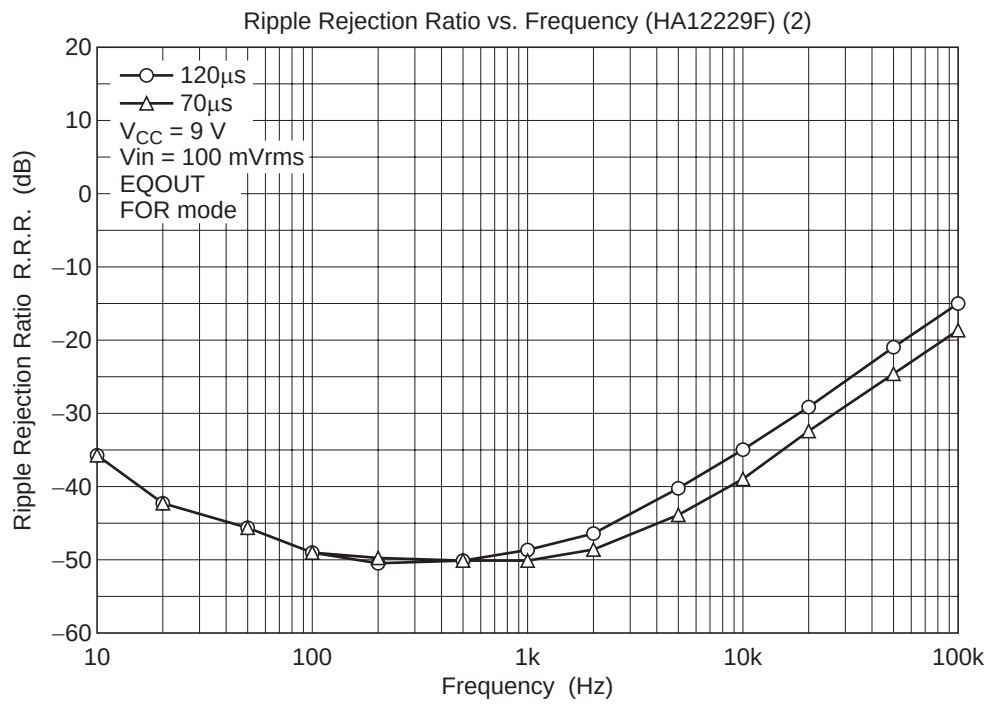


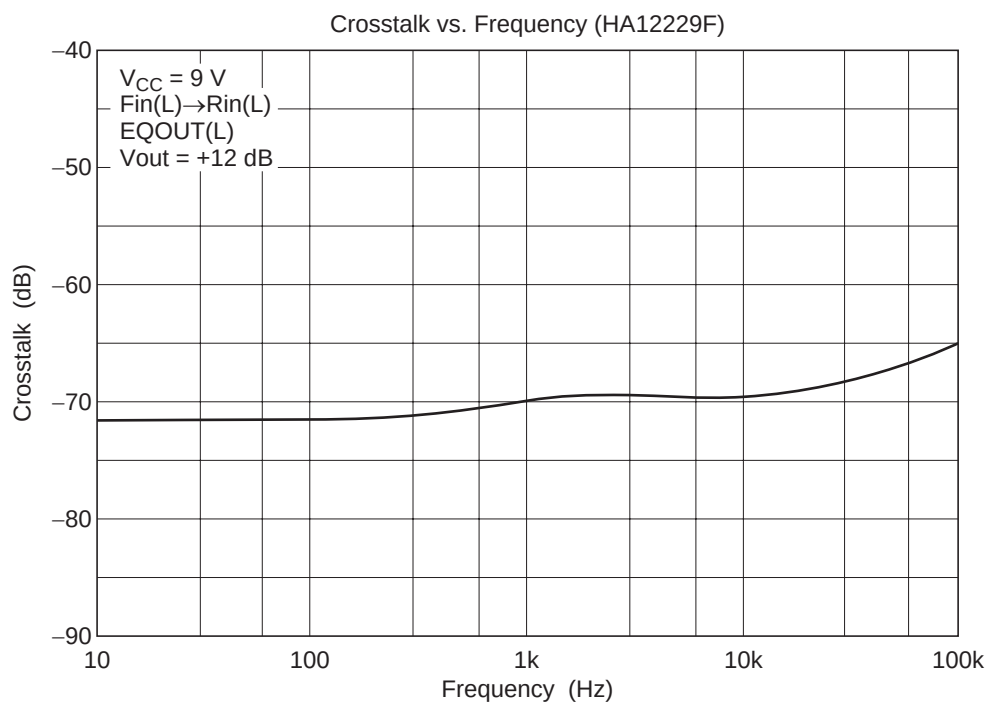
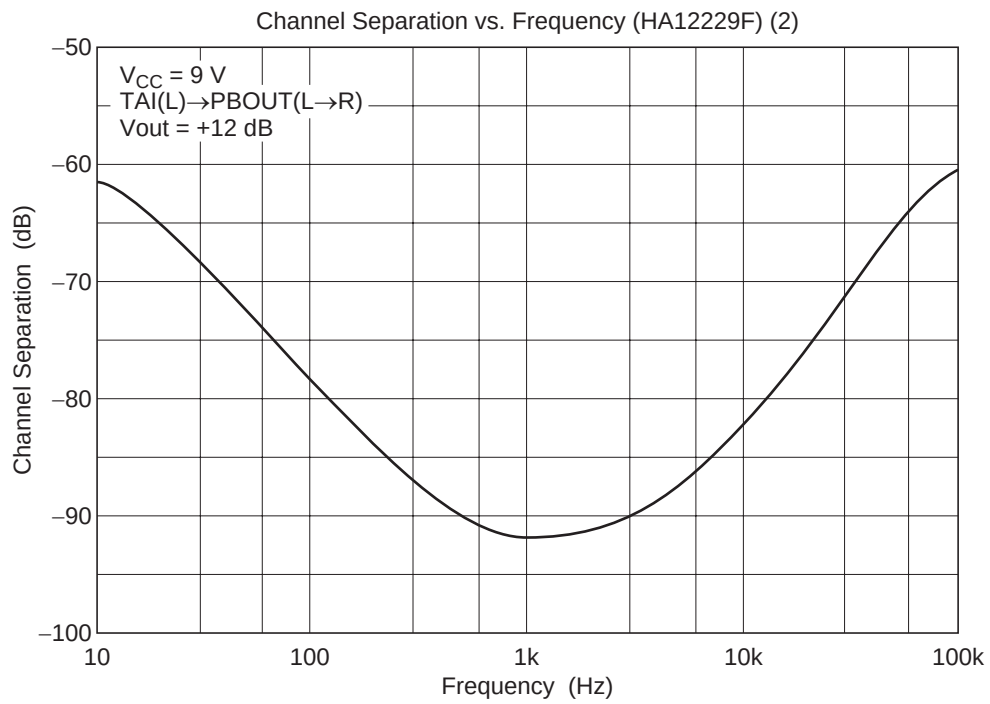


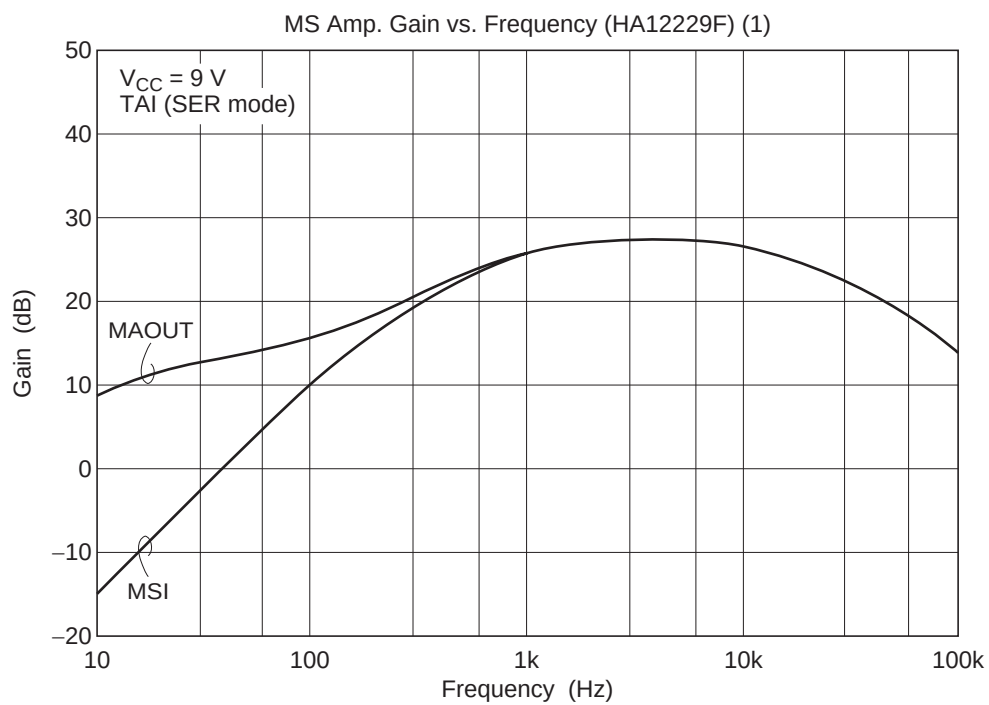
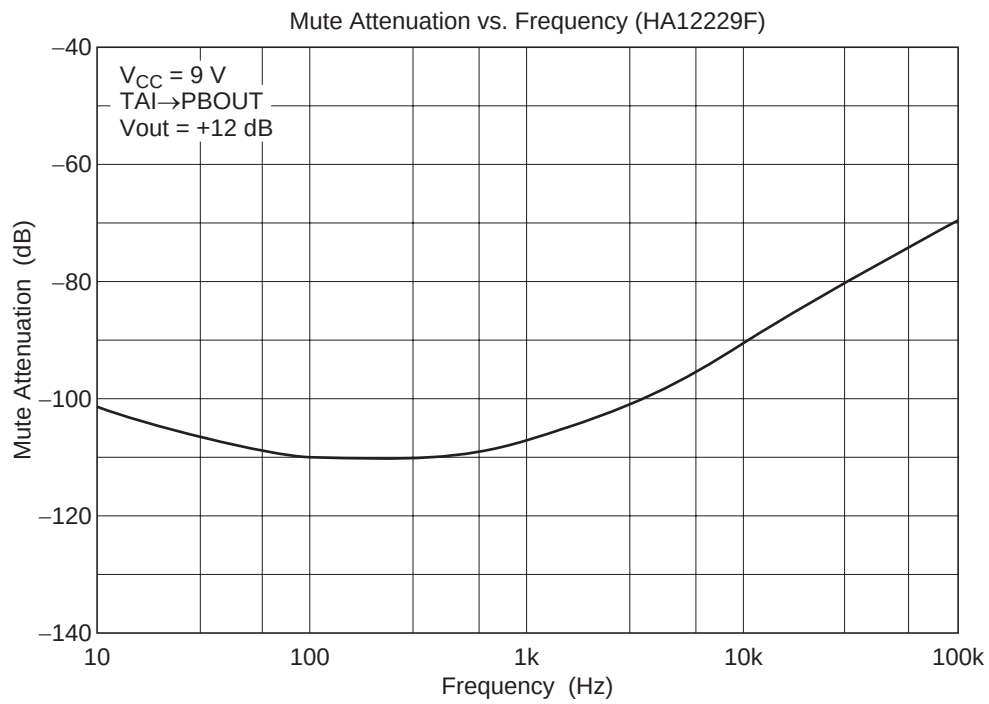


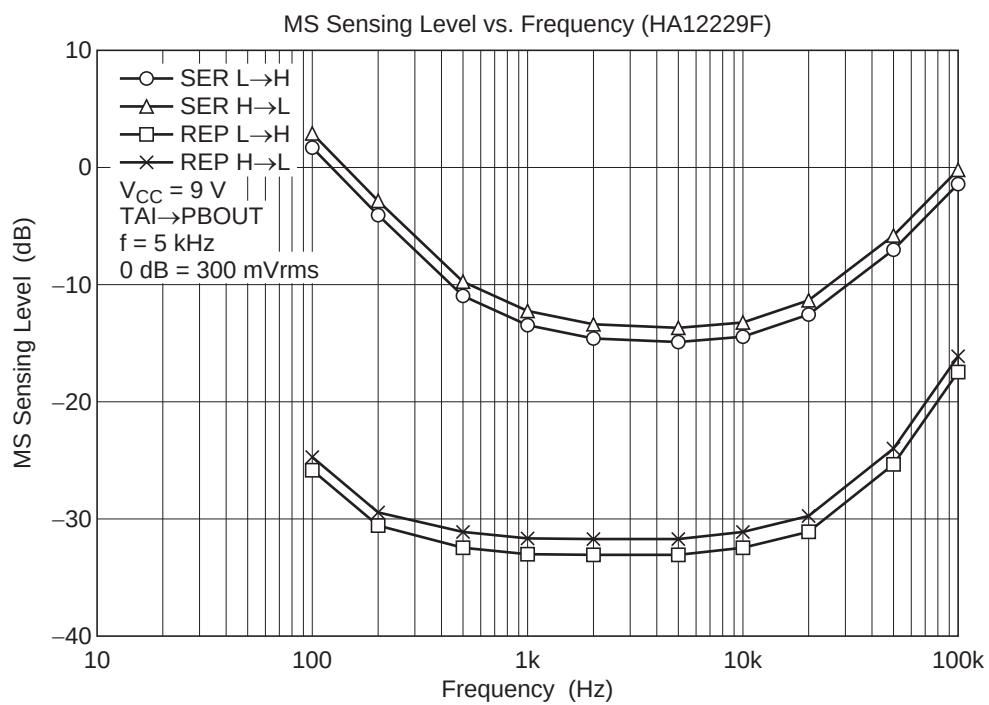
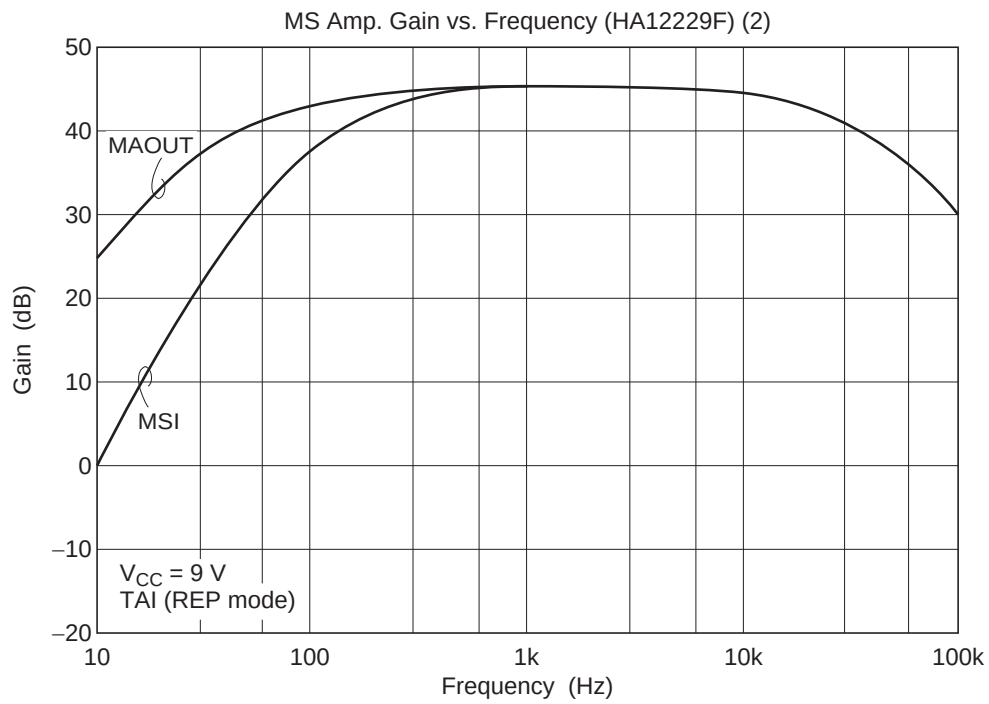


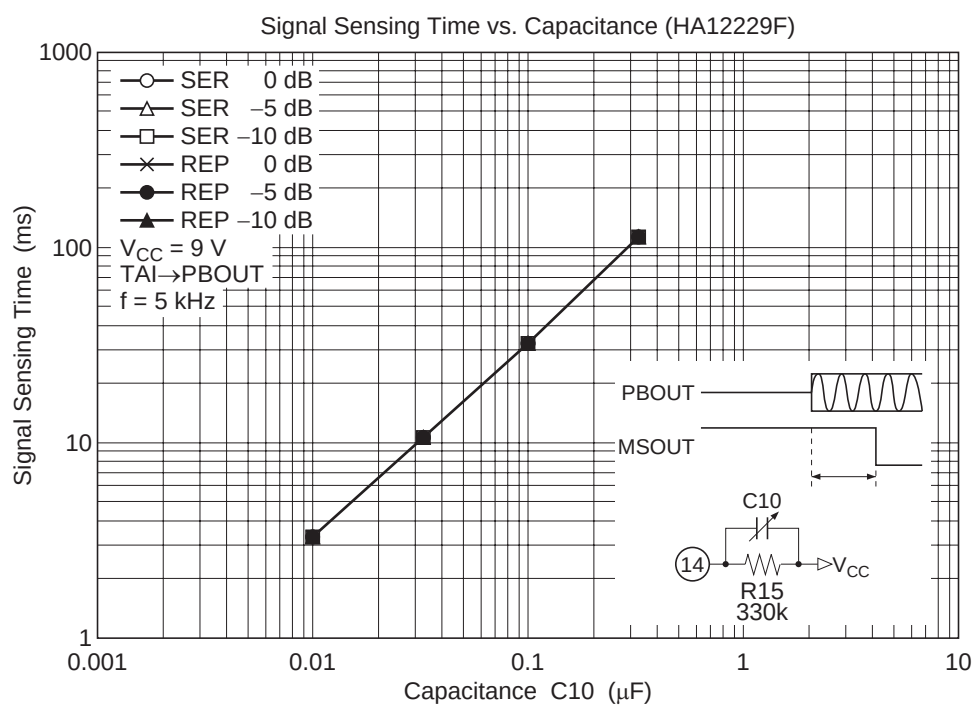
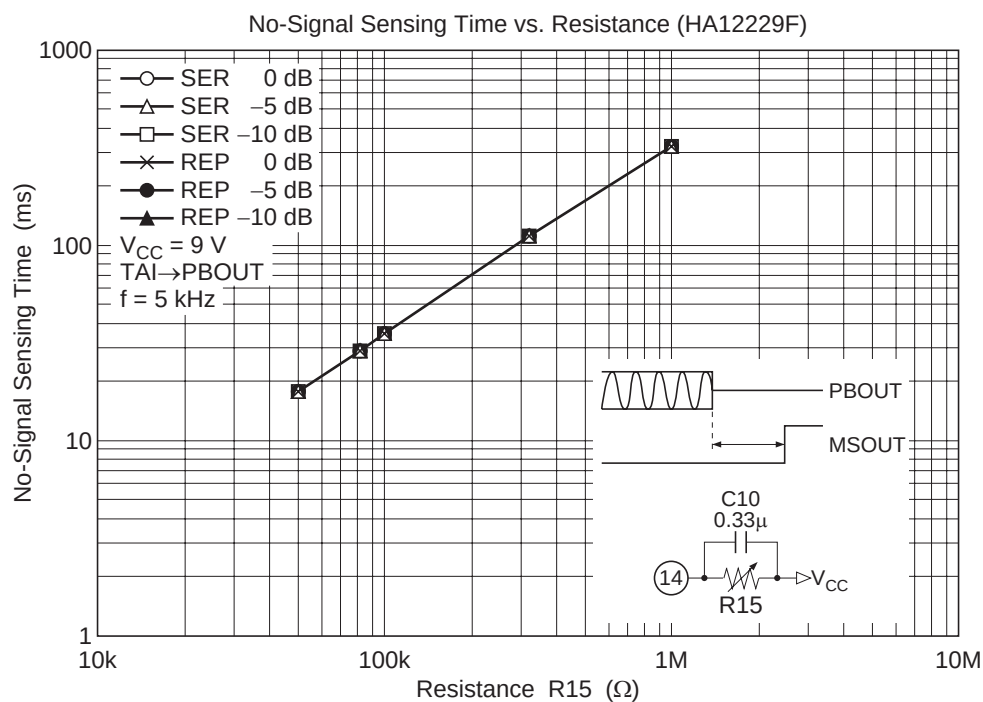




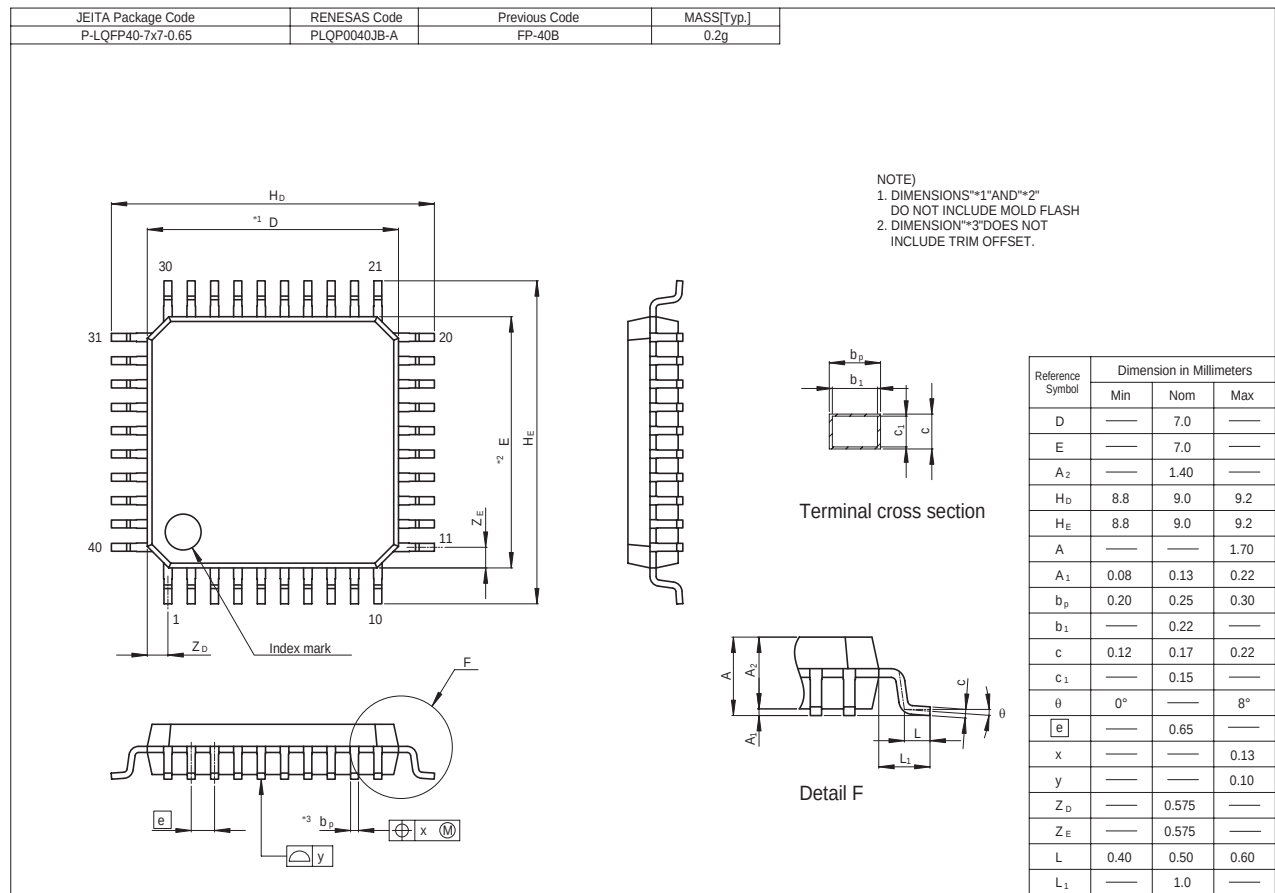








Package Dimensions



Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
The information described here may contain technical inaccuracies or typographical errors.
Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (<http://www.renesas.com>).
4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



RENESAS SALES OFFICES

<http://www.renesas.com>

Refer to "<http://www.renesas.com/en/network>" for the latest and detailed information.

Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.

10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.